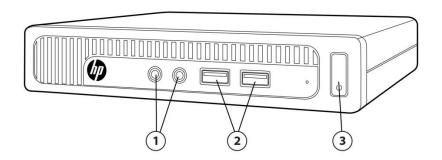
### Overview

## HP ProDesk 600 G1 Desktop Mini Business PC



- 1. 3.5mm headphone output and microphone jacks
- 2. (2) Front USB 3.0 ports (One fast charging port)
- 3. Power button and PC status LED

### **Not Shown**

Slots (1) internal M.2 PCIe x4 connector for optional wireless NIC

(1) internal M.2 PCIe x4connector for optional SSD drive

Bays (1) 2.5" internal storage drive bay

Rear I/O (2) USB 3.0 ports; (2) USB 2.0 ports

(1) VGA video port; (2) DisplayPort with multi-stream video ports

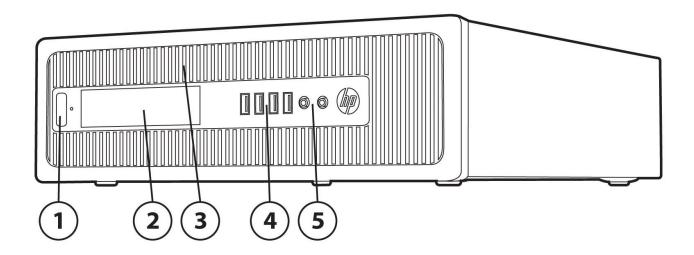
(1) RJ-45 network connector

3.5mm audio out jack

VESA Support for VESA 100mm mounting system on bottom of PC chassis

Overview

### **HP ProDesk 600 G1 Small Form Factor Business PC**



- 1 Power button and PC status LED
- 2 3.5" external drive bay; used for installing a Media Card Reader or 2<sup>nd</sup> data storage drive
- 3 Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 4 (2) USB 3.0 ports, (2) USB 2.0 ports
- 5 3.5mm headphone output and microphone jack

### Not Shown

Slots (1) PCI Express x16 graphics connector

(3) PCI Express x1 accessory connectors

Bays (1) 2.5" internal storage drive bay

(1) 3.5" internal storage drive bay

Rear I/O (2) USB 3.0 ports; (4) USB 2.0 ports

(1) VGA video port; (2) DisplayPort with multi-stream video ports

(1) RJ-45 network connector

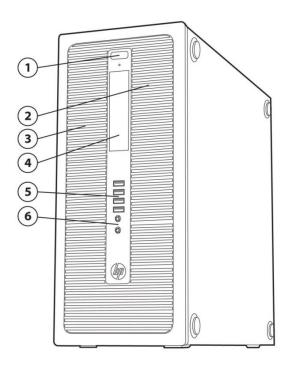
(1) RS-232 serial port

3.5mm audio in/out jacks

PS/2 keyboard and mouse ports

Overview

### **HP ProDesk 600 G1 Tower Business PC**



- 1 Power button and PC status LED
- 2 Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 3 5.25" half height external drive bay (located behind removable bezel)
- 4 3.5" external drive bay; used for installing a Media Card Reader
- 5 (2) USB 3.0 ports, (2) USB 2.0 ports
- 6 3.5mm headphone output and microphone jack

#### Not Shown

Slots (1) PCI Express x16 graphics connector

(3) PCI Express x1 accessory connector

Bays (1) 2.5" internal storage drive bay

(2) 3.5" internal storage drive bay

Rear I/O (2) USB 3.0 ports; (4) USB 2.0 ports

(1) VGA video port; (2) DisplayPort with multi-stream video ports

(1) RJ-45 network connector

(1) RS-232 serial port

3.5mm audio in/out jacks

PS/2 keyboard and mouse ports



#### Overview

### **AT A GLANCE**

- Choice of Desktop Mini, Small Form Factor or Tower chassis options
- PC chassis and all internal components and modules are manufactured with low halogen content
- HP developed and engineered UEFI BIOS supporting security, manageability and software image stability
- Intel® Q85 chipset supporting Intel 4th generation Core processors, featuring integrated Intel HD Graphics and Intel® Standard Manageability Technology
- Processor support up to 84W (TWR/SFF), 35W (DM)
- Intel® Ethernet Connection I217L GbE LOM integrated network connection
- DDR3 Synchronous Dynamic Random Access Memory (SDRAM)
- Multi-independent monitor support via VGA and dual digital DisplayPort video interfaces with multi-stream
- Discrete graphics options available for SFF and TWR platforms
- DTS+ Sound audio management software
- Standard and high efficiency energy saving power supply options
- ENERGY STAR® qualified and certified EPEAT® Gold models
- Guaranteed lengthy purchase lifecycles and image stability



### Technical Specifications - Graphics

	<u>им</u>	<u> 5FF/ I WK</u>
Intel® Q85 Express	X	X

#### **PROCESSOR**

Intel® 4th Generation Core™ i7 Processors	<u>DM</u>	SFF/TWR
Intel® Core™ i7-4790 Processor		X

Up to 4.0 GHz Max. Turbo Frequency (3.6 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

tel® Core™ i7-4790S Processor X (only SFF)

Up to 4.0 GHz Max. Turbo Frequency (3.2 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate

<u>Intel® Core™ i7-4785T Processor</u> X

Up to 3.2 GHz Max. Turbo Frequency (2.2 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel® HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate

Intel Core i7-4771 Processor

Up to 3.9 GHz Max. Turbo Frequency (3.5 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i7-4770 Processor

Up to 3.9 GHz Max. Turbo Frequency (3.4 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate

<u>Intel® Core™ i7-4765T Processor</u> X

Up to 3.0 GHz Max. Turbo Frequency (2.0 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate

## Intel® 4th Generation Core™ i5 Processors DM SFF/TWR

Intel® Core™ i5-4690 Processor
Up to 3.9 GHz Max. Turbo Frequency (3.5 GHz base frequency)
6 MB cache, 4 cores, 4 threads
Intel HD Graphics 4600
Supports DDR3 memory up to 1600 MT/s data rate

### **Technical Specifications - Graphics**

Intel® 4th Conception CoveTM: 3 Dycosocova	DM	CEE/TWD
Intel® Core™ i5-4570S Processor Up to 3.6 GHz Max. Turbo Frequency (2.9 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate		X (only SFF)
Intel® Core™ i5-4570T Processor  Up to 3.6 GHz Max. Turbo Frequency (2.9 GHz base frequency)  4 MB cache, 2 cores, 4 threads Intel HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate	X	
Intel® Core™ i5-4570 Processor  Up to 3.6 GHz Max. Turbo Frequency (3.2 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate		X
Intel® Core™ i5-4670 Processor  Up to 3.8 GHz Max. Turbo Frequency (3.4 GHz base frequency)  6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate		X
Intel® Core™ i5-4590T Processor  Up to 3.0 GHz Max. Turbo Frequency (2.0 GHz base frequency), 6 MB cache, 4 cores, 4 threads Intel® HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate	X	
Intel® Core™ i5-4590 Processor  Up to 3.7 GHz Max. Turbo Frequency (3.3 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate		х
ical Specifications - Grapnics		

Intel® 4th Generation Core™ i3 Processors	<u>DM</u>	SFF/TWR
Intel® Core™ i3-4370 Processor		X
3.8 GHz base frequency		
4 MB cache, 2 cores, 4 threads		
Intel® HD Graphics 4600		
Supports DDR3 memory up to 1600 MT/s data rate		
Intel® Core™ i3-4360 Processor		X
3.7 GHz base frequency		
4 MB cache, 2 cores, 4 threads		
Intel® HD Graphics 4600		
Supports DDR3 memory up to 1600 MT/s data rate		
Intel® CoveTM 12, 42 FO Diversessor		v
I <u>ntel® Core™ i3-4350 Processor</u>		X



X

X

X

X

X

X

X

X

## QuickSpecs

### **Technical Specifications - Graphics**

3.6 GHz base frequency 4 MB cache, 2 cores, 4 threads Intel® HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4350T Processor
3.1 GHz base frequency
4 MB cache, 2 cores, 4 threads
Intel® HD Graphics 4600
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4340 Processor
3.6 GHz base frequency
4 MB cache, 2 cores, 4 threads
Intel HD Graphics 4600
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4330 Processor
3.5 GHz base frequency
4 MB cache, 2 cores, 4 threads
Intel HD Graphics 4600
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4330T Processor
3.0 GHz base frequency
4 MB cache, 2 cores, 4 threads
Intel HD Graphics 4600
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4170 Processor
3.7 GHz base frequency
3 MB cache, 2 cores, 4 threads
Intel® HD Graphics 4400
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4160 Processor

3.6 GHz base frequency

3 MB cache, 2 cores, 4 threads
Intel® HD Graphics 4400

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4150 Processor
3.5 GHz base frequency
3 MB cache, 2 cores, 4 threads
Intel® HD Graphics 4400
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4150T Processor
3.0 GHz base frequency
4 MB cache, 2 cores, 4 threads
Intel® HD Graphics 4400
Supports DDR3 memory up to 1600 MT/s data rate

## **Technical Specifications - Graphics**

Intel® Core™ i3-4130 Processor 3.4 GHz base frequency 3 MB cache, 2 cores, 4 threads Intel HD Graphics 4400 Supports DDR3 memory up to 1600 MT/s data rate		X
Intel® Core™ i3-4130T Processor 2.9 GHz base frequency 3 MB cache, 2 cores, 4 threads Intel HD Graphics 4400 Supports DDR3 memory up to 1600 MT/s data rate	х	
Intel® Core™ i3-4160T 3.1 GHz base frequency, 3 MB cache, 2 cores, 4 threads Supports DDR3 memory 1600 MT/s data rate Intel HD Graphics 4400	х	Х
Intel® Core™ i3-4360T  3.2 GHz base frequency, 4 MB cache, 2 cores, 4 threads Supports DDR3 memory 1600 MT/s data rate Intel HD Graphics 4600	x	х
Intel® 4th Generation Pentium™ Processors  Intel® Pentium G3470 Processor  Up to 3.6 GHz Base Frequency  3 MB cache, 2 cores, 2 threads Intel HD Graphics  Supports DDR3 memory up to 1600 MT/s data rate	<u>DM</u>	<u>SFF/TWR</u> X
Intel® Pentium G3460 Processor Up to 3.5 GHz Base Frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate		х
Intel® Pentium G3450 Processor Up to 3.4 GHz Base Frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate		X
Intel® Pentium G3440 Processor Up to 3.3 GHz Base Frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate		X
Intel® Pentium™ G3440T Processor  2.8 GHz base frequency  3 MB cache, 2 cores, 2 threads Intel® HD Graphics	х	



X

X

X

X

X

X

X

X

## QuickSpecs

### **Technical Specifications - Graphics**

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Pentium G3430 Processor

Up to 3.3 GHz base frequency

3 MB cache, 2 cores, 2 threads
Intel HD Graphics

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Pentium G3420 Processor
Up to 3.2 GHz base frequency
3 MB cache, 2 cores, 2 threads
Intel HD Graphics
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Pentium™ G3420T Processor

2.7 GHz base frequency

3 MB cache, 2 cores, 2 threads
Intel HD Graphics

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Pentium™ G3240T Processor

2.7 GHz base frequency

3 MB cache, 2 cores, 2 threads
Intel® HD Graphics

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Pentium G3260 Processor
Up to 3.3 GHz Base Frequency
3 MB cache, 2 cores, 2 threads
Intel HD Graphics
Supports DDR3 memory up to 1333 MT/s data rate

Intel® Pentium G3250 Processor
Up to 3.2 GHz Base Frequency
3 MB cache, 2 cores, 2 threads
Intel HD Graphics
Supports DDR3 memory up to 1333 MT/s data rate

Intel® Pentium G3240 Processor
Up to 3.1 GHz Base Frequency
3 MB cache, 2 cores, 2 threads
Intel HD Graphics
Supports DDR3 memory up to 1333 MT/s data rate

Intel® Pentium G3220 Processor
Up to 3.0 GHz base frequency
3 MB cache, 2 cores, 2 threads
Intel HD Graphics
Supports DDR3 memory up to 1333 MT/s data rate



## **Technical Specifications - Graphics**

Intel® Pentium™ G3220T Processor  2.6 GHz base frequency	x	
3 MB cache, 2 cores, 2 threads Intel HD Graphics		
Supports DDR3 memory up to 1333 MT/s data rate		
Intel® Pentium® G3250T  2.8 GHz base frequency, 3 MB cache, 2 cores, 2 threads Intel HD Graphics  Supports DDR3 memory 1333 MT/s data rate	X	
Intel® Pentium® G3450T 2.9 GHz base frequency, 3 MB cache, 2 cores, 2 threads Intel HD Graphics	X	
Supports DDR3 memory 1600 MT/s data rate		
Intel® 4th Generation Celeron™ Processors	<u>DM</u>	SFF/TWR
Intel® Celeron™ G1850 Processor  2.9 GHz base frequency  2 MB cache, 2 cores, 2 threads Intel® HD Graphics  Supports DDR3 memory up to 1600 MT/s data rate		х
Intel® Celeron™ G1840 Processor		X
2.8 GHz base frequency 2 MB cache, 2 cores, 2 threads		
Intel® HD Graphics		
Supports DDR3 memory up to 1600 MT/s data rate		
Intel® Celeron™ G1840T Processor  2.5 GHz base frequency  2 MB cache, 2 cores, 2 threads	х	
Intel® HD Graphics		
Supports DDR3 memory up to 1600 MT/s data rate		
Intel® Celeron™ G1830 Processor		X
2.8 GHz base frequency 2 MB cache, 2 cores, 2 threads		
Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate		
Available February '14		
Intel® Celeron™ G1820 Processor  2.7 GHz base frequency  2 MB cache, 2 cores, 2 threads		x
Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate Available February '14		
Intel® Celeron™ G1820T Processor 2.4 GHz base frequency	x	
2 MB cache, 2 cores, 2 threads Intel HD Graphics		
Supports DDR3 memory up to 1333 MT/s data rate		



SFF/TWR

X

<u>DM</u>

X

## QuickSpecs

### **Technical Specifications - Graphics**

Intel HD Graphics on all models (integrated on processor)

### **GRAPHICS\***

\*NOTE: AMD and NVIDIA graphics cards are not available on configurations with the preinstalled Windows 10 operating system. Configurations with the Windows 10 downgrade to Windows 7 operating system will allow for upgrading to Windows 10 with AMD and NVIDIA graphics cards through graphics driver installation from hp.com.

Optional Discrete Graphics Solutions	<u>DM</u>	SFF/TWR
AMD Radeon HD 8350 (1GB) PCIe x16		X
AMD Radeon HD 8490 (1GB) PCIe x 16		X
AMD Radeon R7 240 2GB FH PCIe x16 GFX		X
AMD Radeon R9 255 2GB FH PCIe x16 GFX		TWR only
NVIDIA NVS 310 (512 MB) PCIe x16		X
NVIDIA NVS 315 (1GB) PCIe x 16		X
NVIDIA GeForce GT630 (2 GB) FH PCIe x16		TWR only
Adapters and Cables	<u>DM</u>	SFF/TWR
HP DMS-59 to Dual DisplayPort Cable		X
HP DMS-59 to Dual DVI Cable		X
HP DMS-59 to Dual VGA Cable		X
HP DisplayPort to DisplayPort Cable	х	X
HP DisplayPort to DVI-D Adapter	х	X
HP DisplayPort to HDMI Adapter	X	X
HP DisplayPort To HDMI 1.4 Adapter	х	X
HP DisplayPort to VGA Adapter	х	X
HP Serial Port Adapter		X
HP Parallel Port Adapter		X
STORAGE*		
Hard Disk Drive (HDD)	<u>DM</u>	SFF/TWR
320 GB 7200 rpm HDD	<del></del>	x
500 GB 7200 rpm HDD	x	X
500 GB 7200 rpm SED HDD	x	X
500 GB 10K rpm HDD		X
1 TB 7200 rpm HDD		X
1 TB 10K rpm HDD		X
2 TB 7200 rpm HDD		X
Solid State Hybrid Drives (SSHD)	<u>DM</u>	SFF/TWR
500 GB SSHD (8 GB cache)	х	X
500GB SATA 6G 2.5 8G SSHD	X	
1 TB SSHD (8 GB cache)	Х	X



<u>DM</u>

## QuickSpecs

### **Technical Specifications - Graphics**

1TB SATA 6G 2.5 8G SSHD	X	
Solid State Drives (SSD) & Self-encrypting Solid State Drives (SED)	<u>DM</u>	SFF/TWR
120 GB SATA 2.5 Non-SED SSD (with 3.5" adapter when needed)	X	X
180 GB SATA 2.5 Non-SED SSD (with 3.5" adapter when needed)	X	X
120 GB Opal SED	X	X
120 GB SATA 2.5 Opal2 SED SSD (with 3.5" adapter when needed)	X	X
180 GB SATA 2.5 Opal2 SED SSD (with 3.5" adapter when needed)	X	X
Intel Pro 1500 120gb SSD Opal 1 SED drive SRP	X	
120 GB SATA 2.5 2nd Opal1 SED SSD	X	
128 GB SSD Non-SED		X
128 GB Opal SED	X	X
128 GB Turbo Drive SSD (M.2 PCIe)	X	
128 GB SATA 2.5 2nd Opal2 SED SSD	X	
180 GB Opal SED	X	X
Intel Pro 1500 180gb SSD Opal 1 SED drive	X	
256 GB SED		X
256 GB Opal SED	X	X
256 GB SATA 2.5 SSD (Non-SED)	X	X
128GB SATA 2.5 SSD TLC Non-SED (with 3.5" adapter when needed)	X	X (TWR)
256GB SATA 2.5 SSD TLC Non-SED (with 3.5" adapter when needed)	X	X (TWR)
512 GB SATA 2.5 SSD (Non-SED)	X	Х
Optical Disc Drives	<u>DM</u>	SFF/TWR
Slim DVD-ROM		X
Slim BDXL Blu-ray Writer		X
Slim SuperMulti DVD Writer		X
HH Supermulti ODD		TWR only

\*NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

### **MEMORY**

Removable

HP Slim Removable SATA HDD Frame/Carrier

Form Factor	Туре	Maximum	# of Slots
Desktop Mini	DDR3 non-ECC up to 1600 MT/s	16 GB	2 SODIMM
Small Form Factor	DDR3 non-ECC Up to 1600 MT/s	32 GB	4 DIMM
Tower	DDR3 non-ECC Up to 1600 MT/s	32 GB	4 DIMM



SFF/TWR

X

### **Technical Specifications - Graphics**

**NOTE:** For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Memory modules support data transfer rates up to 1600 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

### **NETWORKING/COMMUNICATIONS**

DTS Sound + audio management technology

Line-out and Line-In rear Ports\* (3.5mm)

Multi-streaming capable\*

Internal speaker (standard)

Microphone\* and headphone front ports (3.5mm)

Ethernet (RJ-45) Intel I217LM Gigabit Network Connection (standard) Intel Ethernet I210-T1 PCIe x1 Gb Network Interface Card (optional)	<u>DМ</u> Х	<u>SFF/TWR</u> X X
Wireless  HP WLAN 802.11 a/g/n 2x2 DualBand PCIe x1 Card (optional)	<u>DM</u>	<u>SFF/TWR</u> X
Intel Centrino Advanced-N 6205 802.11 a/b/g/n PCI Express x1 Wireless Network Connection (optional)		x
Intel Wireless-N 7260 802.11 M.2 a/b/g/n NIC Card Wireless Network Connection (optional)	x	
Intel Wireless-N 7260 802.11 a/b/g/n PCIe x1 NIC Wireless Network Connection (optional)		x
Intel 7260 802.11 a/b/g/n M.2 BT NIC	X	Х
AUDIO/MULTIMEDIA		
Audio	<u>DM</u>	SFF/TWR
HD audio with Realtek ALC221 codec (all ports are stereo)	X	Х

X

X

Line out only

X

X



X

X

X X

X

<sup>\*</sup> The front microphone port is re-taskable as a Line-in, Microphone-in or Headphone-out port. Rear audio input ports are re-taskable as a Line-in or Microphone-in port. External speakers must be powered externally. Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks. This allows for different audio applications to use separate audio ports on the system. For example, the front jacks could be used with a headset for a communications application while the rear jacks are being used with external speakers and a multimedia application.

### **Technical Specifications - Graphics**

#### **KEYBOARDS AND POINTING DEVICES**

Keyboard	<u>DM</u>	SFF/TWR
HP PS/2 Keyboard		X
HP USB Keyboard	X	X
USB Smart Card (CCID) Keyboard	X	X
HP USB and PS/2 Washable Keyboard	X	X
HP Wireless Keyboard and Mouse Combo*	X	X
HP USB Antimicrobial Keyboard	X	X
*Keyboard contains 25% post-consumer recycled plastic material.		
Mice	<u>DM</u>	SFF/TWR
HP PS/2 Mouse		X
HP USB Mouse	X	X
HP USB 1000dpi Laser Mouse	X	X
HP USB and PS/2 Washable Mouse	X	X
HP USB Antimicrobial Mouse	X	X

### **HP BIOS**

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP ProDesk 600 G1 Series Business PC into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification 2.1
- Computrace agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (DOSFlash), BIOS updates from within Windows (HPQFlash), HP Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

#### Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and
  configuration management, allowing operating systems and applications to manage power based on activity and
  usage. HP Elite models use ACPI to provide power conservation features.



### **Technical Specifications - Graphics**

S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W is S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.

#### **SECURITY**

	<u>DM</u>	<u>SFF/TWR</u>
Common Criteria Certified, Infineon TPM SLB9656TT1.2- v4.32 FW	X	X
SATA port disablement (via BIOS)	X	X
Drive lock	X	X
Intel® Identify Protection Technology (IPT) <sup>1</sup>	X	X
Serial, parallel, USB enable/disable (via BIOS)	X	X
Optional USB Port Disable at factory (user configurable via BIOS)	X	X
Removable media write/boot control	X	X
Power-On password (via BIOS)	X	X
Setup password (via BIOS)	X	X
HP Chassis (1 bay) Security Kit		TWR only
Solenoid Hood Lock / Sensor	X	X
Support for chassis padlocks and cable lock devices	X	X

<sup>&</sup>lt;sup>1</sup>Models configured with Intel Core processors have the ability to utilize advanced security protection for online transactions. IPT, used in conjunction with participating web sites, provides double identity authentication by adding a hardware component in addition to the usual user name and password. IPT is initialized through an HP Client Security module

### **ENVIRONMENTAL & REGULATORY**

ENERGY STAR® qualified models available

EPEAT® registered where applicable/supported. See <a href="http://www.epeat.net">http://www.epeat.net</a> for registration status by country. Low halogen (chassis, all internal components and modules)

TAA compliant

#### **Ports**

I/O Ports - Standard	<u>DM</u>	<u>SFF/TWR</u>
VGA video port	1 (rear)	1 (rear)
DisplayPort with multi-stream video ports	2 (rear)	2 (rear)
USB 2.0	2 (rear)	2 (front); 4 (rear)
USB 3.0	2 (front); 2 (rear)	2 (front); 2 (rear)
Serial (RS-232)	N/A	1
PS/2	N/A	1 keyboard (purple) 1 mouse (green)
Audio	3.5mm headphone & microphone jack (front) 3.5mm audio out jack (rear)	3.5mm headphone & microphone jack (front) 3.5mm audio in & out jacks (rear)
Network Interface	1 RJ-45	1 RJ-45



### **Technical Specifications - Graphics**

I/O Ports - Optional	<u>DM</u>	<u>1</u>	SFF/TWR
2nd Serial (RS-232)	N/A	1	
Parallel	N/A	1	

### **SLOTS**

	<u>DM</u>	<u>SFF</u>	<u>TWR</u>
PCI Express x1(v2.0)	N/A	3 ea. 2.5" low profile 6.6" length 10W max. power	3 ea. 4.2" full height 6.6" length 10W max. power
PCI Express x16 (v3.0)	N/A	1 ea. 2.5" low profile 6.6" length 35W max. power	1 ea. 4.2" full height 6.6" length 75W max. power
M.2	1 ea. M.2-2230 (for WLAN) 1 ea. M.2-2280 (for storage drives)	N/A	N/A

### **BAYS**

	<u>DM</u>		SFF/TWR
Media Card Reader	N/A	1	
Slim Optical Disc Drive	N/A	1	
3.5" internal storage drive	N/A	1 – SFF 2 – TWR	
2.5" internal storage drive	1	1	

#### SERVICE AND SUPPORT

On-site Warranty 1: Three-year (3-3-3) limited warranty delivers three years of on-site, next business day 2 service for parts and labor and includes free telephone support 3 24 x 7. Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing a Care Pack. To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/go/cpc

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured and third-party HP qualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

### **OPERATING SYSTEMS**

#### **Preinstalled**

Windows 10 Pro 64\* Windows 10 Home 64\* Windows 8.1 Pro 64\* Windows 8.1 64\*

Windows 7 Professional 64 (available through downgrade rights from Windows 10 Pro)\*\*

Windows 7 Professional 32 (available through downgrade rights from Windows 10 Pro)\*\*

Windows 7 Professional 64 (available through downgrade rights form Windows 8.1 Pro)\*\*\*



### **Technical Specifications - Graphics**

Windows 7 Professional 32 (available through downgrade rights form Windows 8.1 Pro)\*\*\*

Windows 7 Professional 64\*

Windows 7 Professional 32\*

#### Pre-installed (Other)

FreeDOS 2.0

Novell SUSE Linux Enterprise Desktop 11

#### Web-supported

Windows 10 Pro 64

Windows 10 Home 64

Windows 8.1 Pro 64

Windows 8.1 64

Windows 7 Professional 64 (available through downgrade rights from Windows 10 Pro)

Windows 7 Professional 32 (available through downgrade rights from Windows 10 Pro)

Windows 7 Professional 64 (available through downgrade rights form Windows 8.1 Pro)

Windows 7 Professional 32 (available through downgrade rights form Windows 8.1 Pro)

Windows 7 Professional 64

Windows 7 Professional 32

Windows 10 Enterprise 64

Windows 8.1 Enterprise 64

Windows 7 Enterprise 64

Windows 7 Enterprise 32

\*NOTE: Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com.

\*\*This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 10 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

\*\*\*This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

SOFTWARE COM	PONENTS AND APPLIC	ATIONS WITH WINDOWS	
Included	Windows 7	Windows 8.1	Windows 10



## **Technical Specifications - Graphics**

	HP DriveLock HP BIOS Protection <sup>3</sup> BIOS Update via Network Master Boot Record Security Power On Authentication Pre-Boot Security Secure Erase <sup>6</sup> Absolute Persistence Module <sup>7</sup>	HP DriveLock HP BIOS Protection <sup>3</sup> HP Disk Sanitizer <sup>4</sup> BIOS Update via Network Master Boot Record Security Power On Authentication Pre-Boot Security Secure Erase <sup>6</sup> Hybrid Boot Measured Boot Secure Boot Absolute Persistence Module <sup>7</sup>	HP BIOSphere¹ HP DriveLock HP BIOS Protection³  BIOS Update via Network Master Boot Record Security Power On Authentication Pre-Boot Security Secure Erase6 Hybrid Boot Measured Boot Secure Boot Absolute Persistence Module7
Multimedia	CyberLink Power2Go (Secure Burn)	CyberLink Power2Go (Secure	CyberLink Power DVD, BD CyberLink Power2Go (Secure Burn)

	Windows 7	Windows 8.1	Windows 10
Communication	Intel® Wireless Display (WiDi) Software for Windows <sup>5</sup> Native Miracast Support <sup>8</sup>	Intel® Wireless Display (WiDi) Software for Windows <sup>5</sup> Native Miracast Support <sup>8</sup>	Intel® Wireless Display (WiDi) Software for Windows <sup>5</sup> Native Miracast Support <sup>8</sup>
HP Value Add	HP ePrint Driver <sup>9</sup> HP Recovery Manager HP Support Assistant HP Recovery Disk Creator	HP ePrint Driver <sup>9</sup> HP Recovery Manager HP Support Assistant HP Recovery Disk Creator	HP ePrint Driver <sup>9</sup> HP Recovery Manager HP Support Assistant Windows 10 Welcome App HP Recovery Disk Creator
3 <sup>rd</sup> Party	Foxit PhantomPDF Express for HP	Foxit PhantomPDF Express for HP	Foxit PhantomPDF Express for HP
Microsoft Products	Buy Office Bing Search Skype	Buy Office Bing Search Skype	Buy Office Bing Search Skype
Manageability	(SDM) HP System Software Manager (SSM) HP Client Catalog <sup>10</sup> HP CIK for Microsoft SCCM <sup>10</sup> LANDESK Management <sup>11</sup>	HP Drive Packs <sup>10</sup> HP SoftPaq Download Manager (SDM) HP System Software Manager (SSM) <sup>10</sup> HP Client Catalog <sup>10</sup> HP CIK for Microsoft SCCM <sup>10</sup> LANDESK Management <sup>11</sup> HP BIOS Config Utility (BCU) <sup>10</sup>	HP Drive Packs <sup>10</sup> HP SoftPaq Download Manager (SDM) HP System Software Manager (SSM) <sup>10</sup> HP Client Catalog <sup>10</sup> HP CIK for Microsoft SCCM <sup>10</sup> LANDESK Management <sup>11</sup> HP BIOS Config Utility (BCU) <sup>10</sup> Discover HP Touchpoint

For more information on HP Client Management Solutions refer to: http://www.hp.com/go/clientmanagement.



### Technical Specifications - Graphics

	Windows 7	Windows 8.1	Windows 10
Security	Absolute Persistence Module <sup>7</sup> HP Device Access Manager HP Drive Encryption <sup>12</sup> HP Disk Sanitizer External Edition HP Security Manager Microsoft Security Essentials <sup>14</sup>	Absolute Persistence Module <sup>7</sup> HP Device Access Manager HP Drive Encryption <sup>12</sup> HP Disk Sanitizer External Edition HP Security Manager Microsoft Defender	Absolute Persistence Module <sup>7</sup> HP Drive Encryption <sup>12</sup> HP Disk Sanitizer External Edition HP Security Manager Microsoft Defender
Standard	Smart Card Reader Security lock slot PrebootAuthenticati on	Smart Card Reader Security lock slot Preboot Authentication	Smart Card Reader Security lock slot Preboot Authentication

**NOTE**: The Absolute Persistence agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S.

For more information on HP Client Security Software Suite, refer to http://www.hp.com/go/clientsecurity.

#### Footnotes:

- 1 Available only on business PCs with HP BIOS.
- 3 May require a manual recovery step if all copies of BIOS are compromised or deleted
- 4 For the use cases outlined in the DOD 5220.22-M Supplement. Only supports traditional Hard Drives.

5 Integrated Intel® Wi-Di Display is available on select configurations only and requires a separate projector, TV or monitor with an integrated or external Wi-Di receiver. For more information on Intel® Wi-Di Display visit <a href="http://www.intel.com/go/wirelessdisplay">http://www.intel.com/go/wirelessdisplay</a>

6 For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.

7 Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

8 Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast

9 Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see <a href="http://www.hp.com/go/eprintcenter">http://www.hp.com/go/eprintcenter</a>). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.

- 10 Not preinstalled, however available on manageability website.
- 11 Subscription required.
- 12 Requires Windows. Data is protected prior to Drive Encryption login. Turning the PC off or into hibernate logs out of Drive Encryption and prevents data access.
- 14 Opt in and internet connection required for updates.

Intel HD Graphics	
VGA Controller	Integrated



## **Technical Specifications - Graphics**

DisplayPort	Multimode capable; supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-Stream Technology for a maximum of 3 displays (including the integrated panel)		
Bus Type	N/A		
RAMDAC	N/A		
Memory	Intel graphics do not have dedicated memory but utilizes some of the computer's system memory The amount of memory used for graphics depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio Video Playback) support for playback of protected video content.  Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.		
	Microsoft Windows 7	Windows 8.1	
Maximum Graphics Memory	Up to 1.7GB	Up to 1.8GB	
		NOTE: the actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.	
Maximum Color Depth	32 bits/pixel	32 bits/pixel	
Graphics/Video API Support	4th Generation Core processors:  • The Processor Graphics contains a refresh of the seventh generation graphics core enabling substantial gains in performance and lower power consumption. Up to 16 EU support.  • Next Generation Intel Clear Video Technology HD Support is a collection of video playback and enhancement features that improve the end user's viewing experience  • Encode/transcode HD content  • Playback of high definition content including Blu-ray Disc  • Superior image quality with sharper, more colorful images  • DirectX Video Acceleration (DXVA) support for accelerating video processing  • Full AVC/VC1/MPEG2 HW Decode  • Advanced Scheduler 2.0, 1.0  • Windows 7, Windows 8, Linux OS Support  • DirectX 11.1  • OpenGL 4.3  • Open CL 1.2		
NOTE: athenus and attenue and the	Supported Display Resolutions and Refresh I		
NUTE: other resolutions may be a Resolutions	available but are not recommended as they may	Refresh Rates	
800x6		60 Hz	
1024x		60 Hz	
1152x8		60 Hz	
1280xi		60 Hz	
1280x		60 Hz	
1280x800 60 Hz			
1280x960 60 Hz		60 Hz	



## **Technical Specifications - Graphics**

1280x1024	60 Hz
1360x768	60 Hz
1366x768	60 Hz
1400x1050	60 Hz
1440x900	60 Hz
1600x900	60 Hz
1600x1200*	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz
1920x1200*	60 Hz
1920x1440*	60 Hz
2560x1440*	60 Hz
2560x1600*	60 Hz
3840x2160*	60 Hz
* Only supported on displays connected to the external DisplayPort connector.	

AMD Radeon HD 7650A Graphics Card		
Form Factor	MXM 3.0	
Graphics Controller	AMD Radeon HD 7650A	
Core Clock	600MHz	
Memory Clock	800MHz	
Memory	2GB, DDR3, 128-bit wide	
Bus Type	мхм	
Max. Power	35W	
Power Source Support	12V and 19V	
3D API Support	DX11, SMS	
HDCP Support	Yes	
Display Max. Resolution	Digital 2560 x 1600 Analog 2048 x 1536	
Supported Graphics APIs	DX11, OpenGL, full 1080p BD (H264) playback in hardware, Multi-Stream DisplayPort support	

### **Supported Display Resolutions and Refresh Rates**

Resolution	Refresh Rates
800 x 600	60 Hz



### **Technical Specifications - Graphics**

Technical Specifications - G	rapriics		
1024 x 768		60 Hz	
1280 x 720		60 Hz	
1280 x 768		60 Hz	
1280 x 1024		60 Hz	
1360 x 7		60 Hz	
1440 x 9		60 Hz	
1600 x 9		60 Hz	
1680 x 10		60 Hz	
1920 x 10		60 Hz	
NVIDIA NVS 310 Graphics	Card		
Introduction	The NVIDIA® NVS™ 310 Graphics Card is a PCI Express low profile form factor graphics add-in card targeted as an active low cost graphics solution for the corporate business and enterprise markets.  The NVIDIA® NVS 310 graphics card is an ideal solution for customers requiring a small form factor graphics add-in card for either standard or small form factor PC designs.		
Performance and Features	The NVIDIA® NVS 310 Graphics Card offers 512 MB of ultrafast DDR3 memory and is capable of supporting up to 2 displays.		
	DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.		
	For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.		
Form Factor	Low Profile: 2.713 × 6.15 in		
Graphics Controller	NVIDIA® NVS 310		
Memory Clock	875MHz		
Memory Size	512 MB DDR3		
Memory Bandwidth	14 GB/s		
Max. Power	19.5W		
Display Max. Resolution	Up to 2560 x 1600 (digital display) per display		
Display Output	Up to 2 displays in the following configurations		
	DisplayPort output:	<ul> <li>Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card</li> <li>Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort Multi-Stream topology technology.</li> </ul>	



## **Technical Specifications - Graphics**

DVI-D output:	<ul> <li>Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors</li> <li>Drives two digital display at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors</li> </ul>
HDMI output:	<ul> <li>NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors</li> </ul>
VGA display output:	<ul> <li>Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors</li> </ul>

### **Supported Display Resolutions and Refresh Rates**

Resolution	Maximum Refresh Rates (Hz) by Connection			
	DisplayPort to VGA	DisplayPort to DVI-D	DisplayPort to HDMI	DisplayPort
640 x 480	85	60	60	60
800 x 600	85	60	60	60
1024 x 768	85	60	60	60
1280 x 720	85	60	60	60
1280 x 1024	85	60	60	60
1440 x 900	75	60	60	60
1600 x 1200	60	60	60	60
1680 x 1050	60	60	60	60
1920 x 1080	60-R	60-R	60	60
1920 x 1200	60-R	60-R		60
1920 x 1440				60
2048 x 1536				60
2560 x 1600				60



## **Technical Specifications - Graphics**

NVIDIA GeForce GT630			
Introduction	The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Card Graphics Card provides a full height, PCI Express x16 graphics add-in card solution based on the NVIDIA Kepler Architecture GPU. The card is designed to support three display connections through its DVII, and two DisplayPort connectors.		
	An ideal solution for desktop PC customers seeking enhanced 2D and advanced 3D graphics performance, the NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards are an excellent choice for business users who want run multiple displays from a single graphics board. Engage in Web conferencing or video or photo editing, while improving your everyday business PC experience with better graphics and excellent visual display quality.		
Performance and Features	The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards deliver superior PCI Express (PCIe) Gen 3 features including:		
	<ul> <li>Unprecedented flexibility for new applications and enhanced performance</li> <li>Support for NVIDIA surround technology</li> <li>Run multiple displays from a single graphics card</li> <li>Full 16 lane PCIe Generation 3 bus support with peak bandwidth support</li> <li>Wireless Display ready for future support</li> </ul>		
Form Factor	PCIe x16 Card		
Graphics Controller	NVIDIA Kepler Architecture GPU		
Core Clock	875 MHz		
Memory Clock	891 MHz		
Memory Size	2 GB DDR3 128 bit		
Memory Bandwidth	28.5 GB/s		
Display Max. Resolution	2560 x 1600 digital, 2048 x 1536 analog		
Display Support	Integrated 400 MHz RAMDAC		

### **Supported Display Resolutions and Refresh Rates**

Resolution	Maximum Refresh Rates (Hz)		
	Analog Connection	Digital Connection	
640 x 480	85	60	
800 x 600	85	60	
1024 x 768	85	60	
1280 x 720	85	60	
1280 x 1024	85	60	
1440 x 900	75	60	
1600 x 1200	85	60	



## **Technical Specifications - Graphics**

1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	60
2048 x 1536	75	60
2560 x 1600	N/A	60

NVIDIA NVS 315 1GB PCIe x 16 Graphics Card			
Introduction	Get efficient dual-display graphics performance in a PCI Express low-profile graphics card with the NVIDIA NVS 315 PCIe x16 1 GB Graphics Card, an ideal desktop graphics solution for professional business and commercial applications.		
Performance and Features	The NVIDIA® NVS 315 Graphics Card offers 1 GB of ultrafast DDR3 memory and is capable of supporting up to 2 displays.		
	DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.		
	For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.		
Form Factor	Low Profile: 2.713 × 6.15 in		
Graphics Controller	NVIDIA® NVS 315		
Memory Clock	875MHz		
Memory Size	512 MB DDR3		
Memory Bandwidth	14 GB/s		
Connectors	DMS-59 , with support for dual VGA, dual DVI or dual Display Port with the appropriate adapter cable		
Display Max. Resolution	Up to 2048 x 1536 VGA; 1920 x 1200 DVI; 2560 x 1600 DisplayPort		
Display Output	Up to 2 displays in the following configurations		
	<ul> <li>Dual DVI:         <ul> <li>Drives two DVI displays using optional HP DMS59 DVI Dual-head Connector Cable DL139A</li> </ul> </li> <li>Dual DisplayPort:         <ul> <li>Drives two DisplayPort using optional HP DMS-59 to Dual DisplayPort kit XP688AA</li> </ul> </li> <li>Dual VGA:         <ul> <li>Drives two analog using the included HP DMS-59 to Dual VGA Cable</li> </ul> </li> </ul>		

### **Supported Display Resolutions and Refresh Rates**



### **Technical Specifications - Graphics**

Resolution	Maximum Refresh R	lates (Hz) by Connection
	Analog Connection	Digital Connection
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	60*
2560 x 1600	N/A	60*
	* Display Port Only	

Memory	2048MB DDR3 128-bit wide frame buffer running at 1800MHz.		
Controller Clock Speed	AMD R14D-M2-70 GPU engine running at 730 MHz.		
Multidisplay Support	Yes (2)		
Graphics /API support	Supports Microsoft DirectX 11.1, OpenGL 4.3 and OpenCL 1.2 APIs. DX 11.1, Shader Model 5, UVD 4.2, VCE 2.0, OpenGL 4.2 (4.1+), OpenCL 1.2, and DirectCompute 11		
Output Connectors	1 x of each DVI-I (VGA via dongle output), and HDMI connectors.		

### **Supported Display Resolutions and Refresh Rates**

Resolution	VGA	DVI-D	HDMI
640x480	85	60	60
720x480	85	60	60
720x576	85	60	60
800x600	85	60	60
1024x768	85	60	60
1280x720	85	60	60
1280x768	85	60	60
1280x1024	85	60	60
1440x900	85	60	60



## **Technical Specifications - Graphics**

1600x1024	85	60	60
1600x1200	85	60	60
1680x1050	75	60	60
1920x1080	85	60*	60
1920x1200	85	60*	NA
1920x1440	85	NA	NA
2048x1536	75	NA	NA
2560x1440	NA	NA	NA
2560x1600	NA	NA	NA
* Requires display with support for reduced blanking timing			

AMD Radeon R9 255 2GB PCIe x16		
Memory 2GB 128-bit wide frame buffer operating at 1150MHz.		
Controller Clock Speed	AMD Cape Verde GPU engine operating at 900 MHz.	
Multidisplay Support	Yes (2)	
Graphics /API support	Supports Microsoft DirectX 11.1, OpenGL 4.3 and OpenCL 1.2 APIs. DX 11.1, Shader Model 5, UVD 4.2, VCE 2.0, OpenGL 4.2 (4.1+), OpenCL 1.2, and DirectCompute 11	
Output Connectors	1 x of each Dual-Link DVI-I, DisplayPort 1.2 and HDMI 1.4 output connectors. DisplayPort and HDMI outputs support audio 1 VGA and 1 DisplayPort1.2	

### **Supported Display Resolutions and Refresh Rates**

SUPPORTED DVI-D (DIGITAL) AND DISPLAYPORT DISPLAY MODES Resolution	Depth (BPP)	Refresh Rate (Hz)
320x200	8, 16, 32	60
320x240	8, 16, 32	60
400x300	8, 16, 32	60
480x360	8, 16, 32	60
512x384	8, 16, 32	60
640x350	8, 16, 32	60
640x400	8, 16, 32	60
640x480	8, 16, 32	60
720x480	8, 16, 32	60
720x576	8, 16, 32	60
800x600	8, 16, 32	60
1024x768	8, 16, 32	60
1152x864	8, 16, 32	60
1280x720	8, 16, 32	60
0.98M9 (1280x768)	8, 16, 32	60
1280x960	8, 16, 32	60
1280x1024	8, 16, 32	60
1.30MA (1440x900)	8, 16, 32	60, 75
1600x900	8, 16, 32	60
1.64MA (1600x1024)	8, 16, 32	60
1600x1200	8,16, 32	60
1.76MA (1680x1050)	8, 16, 32	60
1.76MA-R (1680x1050)	8, 16, 32	75-R



## **Technical Specifications - Graphics**

2.07M9-R (1920x1080)	8, 16, 32	60-R
2.30MA-R (1920x1200)	8, 16, 32	60-R
2560x1440	8, 16, 32	60
2560x1600	8, 16, 32	60
VGA AND DVI-A (ANALOG) DISPI	AY MODES	
Resolution	Depth (bpp)	CRT Refresh Rate (Hz)
320x200	8, 16, 32	60, 75, 85
320x240	8, 16, 32	60, 75, 85
400x300	8, 16, 32	60, 75, 85
480x360	8, 16, 32	60, 75, 85
512x384	8, 16, 32	60, 75, 85
640x350	8, 16, 32	60, 75, 85
640x400	8, 16, 32	60, 75, 85
640x480	8, 16, 32	60, 75, 85
720x480	8, 16, 32	60, 75, 85
720x576	8, 16, 32	50, 60, 75, 85
800x600	8, 16, 32	60, 75, 85
1024x768	8, 16, 32	60, 75, 85
1152x864	8, 16, 32	60, 75, 85
1280x720	8, 16, 32	60, 75, 85
0.98M9 (1280x768)	8, 16, 32	60, 75, 85
1280x960	8, 16, 32	60, 75, 85
1280x1024	8, 16, 32	60, 75, 85
1.30MA (1440x900)	8, 16, 32	60, 75
1600x900	8, 16, 32	60, 75, 85
1.64MA (1600x1024)	8, 16, 32	60, 75, 85
1600x1200	8, 16, 32	60, 75, 85
1.76MA (1680x1050)	8, 16, 32	60, 75
1920x1080	8, 16, 32	60, 75, 85
2.30MA (1920x1200)	8, 16, 32	60, 75, 85
1920x1440	8, 16, 32	60, 75, 85
2048x1536	8, 16, 32	60, 75

AMD Radeon HD 8350 1GB PCie x16 DH Graphics Card		
Introduction	Get stable 2D and advanced 3D graphics performance from the AMD Radeon HD 8350 1 GB PCIe x16 DH Graphics Card, a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon HD 8350 GPU, great for Web conferencing or video and photo editing.	
Form Factor	PCie x16	
Graphics Controller	AMD Radeon HD 8350	
Core Clock	GPU engine operates at 523 MHz	
Memory	1GB, DDR3, SDRAM	
Memory Clock	875 MHz	



## **Technical Specifications - Graphics**

HDCP Support	Yes
Display Max. Resolution	Digital 1920 x 1200 Analog 2048 x 1536

### **Supported Display Resolutions and Refresh Rates**

	Analog Connection	Digital Connection
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	75
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	75-R
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	N/A
2560 x 1600	N/A	N/A

AMD Radeon HD 8490 1GB PCie x16 Graphics Card		
Introduction	Get impressive graphics and high resolution dual-display performance in a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon HD 8490 Graphics Processor. Improve your everyday PC, Web conferencing, and video or photo editing.	
Form Factor	PCie x16	
Graphics Controller	AMD Radeon HD 8490	
Core Clock	GPU engine operates at 875 MHz	
Memory	1GB, DDR3, SDRAM	
Memory Clock	900 MHz	
HDCP Support	Yes	



### **Technical Specifications - Graphics**

**Display Max. Resolution**Digital 2560 x 1600
Analog 2048 x 1536

### **Supported Display Resolutions and Refresh Rates**

	Analog Connection	Digital Connection
300 x 200	85	60
320 x 240	85	60
400 x 300	85	60
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	75
1600 x 900	85	60
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	75-R
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	60
2560 x 1600	N/A	60



### Technical Specifications - Hard Disk and Solid State Storage

### Introduction:

HP Serial Advanced Technology Attachment (SATA) Hard Drives maximize the performance of HP Business PCs by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance.

SATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, the SATA interface connects hard drives to the PC platform enabling easy aggregation of multiple hard drives into a single PC. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability. The HP ProDesk 600 G1 Series Business PC supports the latest SATA 6.0Gb/s specification.

#### **HP Drive Lock**

HP Serial ATA Hard Drives offer enhanced security via a new Drive Lock. When enabled, this ATA security feature set prevents software access to user data on the drive until one or two user-defined passwords are provided.

### **SMART IV Technology**

Self-Monitoring Analysis and Reporting Technology (SMART) hard drive technology allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

#### **Native Command Queuing**

NCQ or Native Command Queuing is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), which allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver. AHCI support is typically implemented in RAID configurations.

**NOTE:** GB = 1 billion bytes. Actual available capacity is less.



HP 500-GB 7200 RPM SATA 2.5" Self-Encrypting (SED) Hard Disk Drive		
Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Drive Type	Self-Encrypting Driv	ve (SED) with SATA interface
Interface	SATA 6 Gb/s	
Segmented Buffer with write cache	32768 KB - A portion of buffer capacity used for firmware	
Number of Sectors	976,773,168	
	Single Track:	1.0 ms
Seek Time (typical reads)	Average:	13 ms
	Full-Stroke: 25 ms	
Media Diameter	2.5 in/63.5 mm	
Height	0.267 in/6.8 mm, ±0.2mm	
Width	2.75 in/69.85 mm, ±0.25mm	
Length	3.945 in/100.2 mm, ±0.25mm	
Weight	3.35 oz/95 g (max)	
Operating Temperature	32° to 140° F (0° to 60° C)	

HP 500-GB 7200 RPM SATA 2.5" Self-Encrypting (SED) Hard Disk Drive		
Capacity	500,107,862,016 bytes	
Rotational Speed	7,200 rpm	
Drive Type	Self-Encrypting Drive (SED) with SATA interface	
Interface	SATA Interface conforming to Serial ATA International Organization: Serial ATA Revision 2.6	
Segmented Buffer with write cache	32768 KB - A portion of buffer capacity used for firmware	
Number of Sectors	976,773,168	



Seek Time (typical reads)	Single Track:	1.0 ms
	Average:	13 ms
	Full-Stroke:	25 ms
Media Diameter	2.5 in/63.5 mm	
Height	0.267 in/6.8 mm, ±0.2mm	
Width	2.75 in/69.85 mm, ±0.25mm	
Length	3.945 in/100.2 mm, ±0.25mm	
Weight	3.35 oz/95 g (max)	
Operating Temperature	32° to 140° F (0° to 60° C)	

HP 1-TB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)			
Formatted Capacity	1 TB		
Spindle Speed	5,400 rpm +/- 0.2%		
Drive Type	Solid State Hybrid Drive	Solid State Hybrid Drive (SSHD) technology with NAND Flash	
Interface	Serial ATA (SATA)		
Cache Buffer	64 MB		
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB		
Number of Sectors	976,773,168		
	Single Track:	2.0 ms	
Seek Time (typical reads)	Average:	12 ms	
Height	0.374 +/008 in (9.5 +/- 0.2 mm)		
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)		
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)		
Weight	0.254 lb/115 g (max)		
Operating Temperature	32° to 140° F (0° to 60° C)		



HP 500 GB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)			
Formatted Capacity	500 GB		
Spindle Speed	5,400 rpm +/- 0.2%	5,400 rpm +/- 0.2%	
Drive Type	Solid State Hybrid Drive	Solid State Hybrid Drive (SSHD) technology with NAND Flash	
Interface	Serial ATA (SATA)		
Cache Buffer	64 MB		
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB		
Number of Sectors	976,773,168		
	Single Track:	2.0 ms	
Seek Time (typical reads)	Average:	12 ms	
Height	0.268 +/008 in (6.8 +/- 0.2 mm)		
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)		
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)		
Weight	0.209 lb/95 g (max)		
Operating Temperature	32° to 140° F (0° to 60° C)		

HP 120 GB Solid State Drive				
Unformatted Capacity	120 GB			
Architecture	Multi Level Cell (MLC) NAND Flash with w	Multi Level Cell (MLC) NAND Flash with wear leveling 10 channel controller		
Interface	Serial ATA 2.0 (3.0 Gb/s)	Serial ATA 2.0 (3.0 Gb/s)		
Dimensions (W x H x D)	2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)			
Weight	0.18 lb (80 g)			
Bandwidth Performance	Sustained Sequential Read:	Up to 250 MB/s		
	Sustained Sequential Write:	Up to 70 MB/s		
	Random Read:	Up to 35K IOPs		



	Random Write:	Up to 6.6K IOPs
Latency	Read:	65-ms
	Write:	85-ms
Power	DC power requirement:	5 VDC 5%-100 mV ripple p-p
	Total power consumption:	0.15W (active); 0.075W (idle)
Useful Drive Life	35TB written, up to 20GB/day for 5 years	
<b>Environmental</b> (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)
	Relative Humidity:	5% to 95%
	Maximum Wet Bulb Temperature (operating):	84° F (29° C)
	Shock:	1,500 G/0.5-ms

<sup>\*</sup> For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

<sup>\*\*</sup> The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

HP 128 GB Solid State Drive				
Unformatted Capacity	128 GB*			
Architecture	Multi Level Cell (MLC) NAND	Multi Level Cell (MLC) NAND		
Interface	SATA 6 GB/sec			
Dimensions (W x H x D)	2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm)			
Weight	0.16 lb (73 g)			
Bandwidth Performance	Sustained Sequential Read:	Up to 450 MB/ss		
	Sustained Sequential Write:	Up to 260 MB/s		
	Random Read (4KB):	up to 46K IOPs		
	Random Write (4KB):	up to 56K IOPs		
Latency	Read:	55ms (TYP)		
	Write:	55ms (TYP)		
Power	DC power requirement:	Min 4.5 V; Max 5.5 V		
	Total power consumption:	160 mW (Active) ; <85 mW; (Idle)		



Useful Drive Life	1.2 million device hours**		
<b>Environmental</b> (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)	
	Relative Humidity (operating):	5% to 95%	
	Shock:	1,500 G/1.0 msec	
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS		
	CISPR 22:2002 Class B, Korea KCC, CE Mark		

<sup>\*</sup> For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

<sup>\*\*</sup> The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

HP 256 GB* (non-SED) TL	C Solid State Drive		
Unformatted Capacity	256 GB*		
Architecture	Triple Level Cell (TLC) NAND		
Interface	SATA 6 GB/sec		
Dimensions (W x H x D)	2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm)		
Weight	0.1 lb (45 g)		
	Sustained Sequential Read:	Up to 510 MB/s	
	Sustained Sequential Write:	Up to 280 MB/s	
Bandwidth Performance	Random Read (4KB):	up to 90K IOPs	
	Random Write (4KB):	up to 70K IOPs	
Latency	Read:	55ms (TYP)	
	Write:	55ms (TYP)	
Power	DC power requirement:	Min 4.75 V; Max 5.25 V	
	Total power consumption:	160 mW (Active) ; <85 mW; (Idle)	
Useful Drive Life	1.2 million device hours**		
<b>Environmental</b> (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)	
	Relative Humidity (operating):	5% to 95%	
	Shock:	1,500 G/1.0 msec	
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea KCC, CE Mark		



### Technical Specifications - Hard Disk and Solid State Storage

\* For solid state disk drives, GB means 1 billion bytes. Actual formatted capacity is less. Up to 16GB for Windows 7 and up to 36GB for Windows 8.1 is reserved for system recovery software.\*\* The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

HP 128 GB* (non-SED) TL	C Solid State Drive		
Unformatted Capacity	128 GB*		
Architecture	Triple Level Cell (TLC) NAND		
Interface	SATA 6 GB/sec		
Dimensions (W x H x D)	2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm	)	
Weight	0.1 lb (45 g)		
	Sustained Sequential Read:	Up to 510 MB/ss	
	Sustained Sequential Write:	Up to 140 MB/s	
Bandwidth Performance	Random Read (4KB):	up to 90K IOPs	
	Random Write (4KB):	up to 36K IOPs	
	Read:	55ms (TYP)	
Latency	Write:	55ms (TYP)	
_	DC power requirement:	Min 4.75 V; Max 5.25 V	
Power	Total power consumption:	160 mW (Active) ; <85 mW; (Idle)	
Useful Drive Life	1.2 million device hours**		
	Operating Temperature:	32° to 158° F (0° to 70° C)	
<b>Environmental</b> (all conditions, non-condensing)	Relative Humidity (operating):	5% to 95%	
	Shock:	1,500 G/1.0 msec	
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea KCC, CE Mark		
*Formatid at a distribution CD manage	1 hillion bytes. Actual formatted capacity is loss. Up to	+- 1000 for Windows 7 and on to 2000 for Windows	

<sup>\*</sup> For solid state disk drives, GB means 1 billion bytes. Actual formatted capacity is less. Up to 16GB for Windows 7 and up to 36GB for Windows 8.1 is reserved for system recovery software.\*\* The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.



HP 512 GB* (non-SED) TL	C Solid State Drive		
Unformatted Capacity	512 GB*		
Architecture	Triple Level Cell (TLC) NAND		
Interface	SATA 6 GB/sec		
Dimensions (W x H x D)	2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm)		
Weight	54 g		
	Sustained Sequential Read:	Up to 510 MB/ss	
Bandwidth Performance	Sustained Sequential Write:	Up to 455 MB/s	
bandwidth Performance	Random Read (4KB):	up to 90K IOPs	
	Random Write (4KB):	up to 60K IOPs	
Latency	Read:	55ms (TYP)	
Latency	Write:	55ms (TYP)	
Power	DC power requirement:	Min 4.75 V; Max 5.25 V	
rowei	Total power consumption: 250 mW (Active); <50 mW; (Idle)		
Useful Drive Life	1.2 million device hours**		
	Operating Temperature:	32° to 158° F (0° to 70° C)	
<b>Environmental</b> (all conditions, non-condensing)	Relative Humidity (operating):	5% to 95%	
	Shock: 1,500 G/1.0 msec		
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea KCC, CE Mark		

HP 128 GB* Turbo Drive SSD (M.2 PCIe card)			
Unformatted Capacity	Unformatted Capacity 128 GB*		
Architecture	NAND Flash Memory which has a high reliability and a high technology in a small form factor for using a SSD and supporting PCIe interface up to 4 lanes.		
Form Factor PCIe SATAe Ultrathin			



Dimensions (Width x Length x Thickness)	.899 x 3.149 x .146 in (22 x 80 x 3.73 mm)		
Weight	0.017 lb (8 g) Max		
Bandwidth Performance -	Sustained Sequential Read (128KB):	Up to 920 MB/ss	
Performance measured using IOMeter 2008 on Windows 8	Sustained Sequential Write (128KB):	Up to 430 MB/s	
64bit. Actual performance may vary depending on use	Random Read (4KB):	up to 8500 IOPs	
conditions and environment.	Random Write (4KB):	up to 32000 IOPs	
<b>D</b>	Allowable voltage	3.3V ± 5%	
Power	Total power consumption:	5.8 W (Active) ; 80 mW; (Idle)	
MTBF	1.5 M hours		
	Operating Temperature:	32° to 158° F (0° to 70° C)	
Environmental (all conditions, non-	Relative Humidity (operating):	5% to 95%	
condensing)	Shock:	1,500 G	
	Safety TUV UL CB c-UL-us	TUV	
		UL CB	
Regulations		c-UL-us	
		TUV	
	EMC/EMI	CE (EU)	
		BSMI (Taiwan)	
		KCC (South Korea)	
		VCCI (Japan)	
		C-Tick (Austrailia)	
		FCC (USA)	

<sup>\*</sup> For solid state disk drives, GB means 1 billion bytes. Actual formatted capacity is less. Up to 16GB for Windows 7 and up to 36GB for Windows 8.1 is reserved for system recovery software. \*\* The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.



Unformatted Capacity	128 GB		
Architecture	Self-Encrypting (SED) Solid State Drive using NAND Flash and SATA interface		
Interface	SATA 6 Gb/s		
Height	.267 in/6.80 mm		
Width	2.75 in/69.85 mm		
Length	3.94 in/100.2 mm		
Weight	0.121 lb (55 g) max		
Performance	Host Transfer Rate:	600 MB/s	
	Sequential Read:	Up to 520 MB/s	
	Sequential Write:	Up to 340 MB/s	
	<ul> <li>* For hard drives, GB = 1 billion bytes. Actual formatted capacity is less. Up to 16GB for Window 7 and up to 36GB for Windows 8.1 is reserved for system recovery software.</li> <li>** NOTEs:</li> <li>1. Measured at HP 8570p@Win7 x64</li> <li>2. Performance measured using CrystaldiskMark 3.01c</li> <li>3. Drive was connected as primary</li> </ul>		
	3. Drive was connected as primary		
		Active* - 0.78A / 3.891W (typical)	
Power	3. Drive was connected as primary  System power consumption:	Active* - 0.78A / 3.891W (typical)  Idle** - 0.005A / 0.026W (typical)	
Power		Idle** - 0.005A / 0.026W (typical)	
Power System Reliability	System power consumption:  * Active power is measured during execution	Idle** - 0.005A / 0.026W (typical)	
System Reliability	* Active power is measured during execution  * Idle power is measured on DOS Idle statu	Idle** - 0.005A / 0.026W (typical)	
	* Active power is measured during execution  ** Idle power is measured on DOS Idle statu  MTBF - 1,500,000 Hours	Idle** - 0.005A / 0.026W (typical) on of IOMeter 2006 in Windows 7 us with DIPM on	



HP 256 GB SATA 2.5" Sel	f-Encrypting (SED) Solid State Drive		
Unformatted Capacity	256,186,209,271 bytes		
Architecture	Self-Encrypting (SED) Solid State Drive with 25nm MLC NAND Flash and SATA interface		
Interface	Serial ATA 2.0 (3.0 Gb/s)		
NAND Flash	25nm MLC NAND Flash		
Height	.275 in/7mm		
Width	2.75 in/69.85 mm		
Length	3.95 in/100.5 mm		
Weight	0.161 lb (73 g)		
	Sustained Sequential 128k Read:	Up to 450 MB/s	
Bandwidth Performance	Sustained Sequential 128k Write:	Up to 260 MB/s	
Danuwiuth Periormante	Random 4k Read:	Up to 46K IOPs	
	Random 4k Write:	Up to 56K IOPs	
Latency	Read:	55 µs	
Latency	Write: 55 μs		
Power	SATA power consumption:  160 mW (active average); <85 mW (idiaverage)		
Useful Drive Life	72TB written, up to 40GB/day for 5 years		
	Operating Temperature:	32° to 158° F (0° to 70° C)	
<b>Environmental</b> (all conditions, non-condensing)	Relative Humidity:	5% to 95%	
	Shock:	1,500 G/1 ms	

HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		
<b>Capacity</b> 500,107,862,016 bytes		
Rotational Speed	7,200 rpm	
Interface Serial ATA 3.0 (6.0 Gb/s)		



Buffer Size	16 MB	
Logical Blocks	976,773,168	
Seek Time (typical reads, includes controller overhead,	Single Track:	2.0 ms
	Average:	11 ms
including settling)	Full-Stroke:	21 ms
Height (nominal)	1 in/2.54 cm	
Milds (againg)	Media diameter: 3.5 in/8.89 cm	
Width (nominal)	Physical size: 4 in/10.2 cm	
Operating Temperature	41° to 131° F (5° to 55° C)	

HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive			
Capacity	1,000,204,886,016 bytes		
Rotational Speed	7,200 rpm		
Interface	Serial ATA 3.0 (6.0 Gb/s)		
Buffer Size	16 MB		
Logical Blocks	1,953,525,168		
Cook Time (typical roads	Single Track:	2.0 ms	
Seek Time (typical reads, includes controller overhead, including settling)	Average:	11 ms	
including setting/	Full-Stroke:	21 ms	
Height (nominal)	1 in/2.54 cm		
Width (nominal)	Media diameter: 3.5 in/8.89 cm		
width (nonlinat)	Physical size: 4 in/10.2 cm		
Operating Temperature	41° to 131° F (5° to 55° C)		



HP 2-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive			
Unformatted Capacity	2 TB	2 TB	
Rotational Speed	7,200 rpm		
Interface	SATA 6Gb/s NCQ	SATA 6Gb/s NCQ	
Cache, Multisegmented (MB)	64 MB		
	Read	<8.5 ms	
Seek Time (average)	Write	<9.5 ms	
Height	1.028 in/26.11 mm	1.028 in/26.11 mm	
Width	4.0 in/101.6 mm		
Depth	5.787 in/146.99 mm		
Weight	1.38 lb/626 g	1.38 lb/626 g	
Operating Temperature	32° to 140° F (0° to 60° C)		



HP Slim SuperMulti DV	D Writer Drive		
Height	12.7mm height		
Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
Disc recording capacity	Up to 8.5 GB DL or 4.7 GB sta	ndard	
<b>Dimensions</b> (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7	7 x 127 mm) without bezel	
Weight (max)	0.42 lb (190 g)		
	DVD-RAM	Up to 5X	
	DVD-R DL	Up to 6X	
	DVD+R	Up to 8X	
	DVD+RW	Up to 8X	
Write speeds	DVD+R DL	Up to 6X	
	DVD-R	Up to 8X	
	DVD-RW	Up to 8X	
	CD-R	Up to 24X	
	CD-RW	Up to 24X	
	DVD-RAM	Up to 5X	
	DVD-RW, DVD+RW	Up to 8X	
	DVD-R DL, DVD+R DL	Up to 8X	
Read speeds	DVD+R, DVD-R	Up to 8X	
	DVD-ROM DL, DVD-ROM	Up to 8X	
	CD-ROM, CD-R	Up to 24X	
	CD-RW	Up to 24X	
Access time	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)	
(typical reads, including	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)	
settling)	Stop Time	6 seconds (typical)	
	Source	Slimline SATA DC power receptacle	
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p	
	DC Current	5 VDC (< 1000 mA typical, 1600 mA maximum)	
	Temperature	41° to 122° F (5° to 50° C)	
Environmental conditions	Relative Humidity	10% to 80%	
(operating - non-condensing)	Maximum Wet Bulb Temperature	84° F (29° C)	



HP Slim Blu-ray BDX	(L Drive			
leight	12.7mm height			
)rientation	Either horizontal or vertical			
nterface type	SATA/ATAPI			
isc recording capacity	Up to 128 GB QL, 100 GE	TL, 50 GB DL or 25 GB standard	d SL	
Dimensions (W x H x D)	5.04 x 0.5 x 5.0 in (128 x	5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel		
Veight (max)	Up to 0.37 lb (170 g) wit	Up to 0.37 lb (170 g) without bezel		
		Triple-layer	Quadruple-layer	
	BD-R	Up to 4X	Up to 4X	
	BD-RE	Up to 2X	Not supported	
		Single-layer	Double-layer	
	BD-R	Up to 6X	Up to 6X	
	BD-RE	Up to 2X	Up to 2X	
	DVD-R	Up to 8X	Up to 6X	
	DVD-RW	Up to 6X	Not supported	
	DVD+R	Up to 8X	Up to 6X	
Vrite speeds	DVD+RW	Up to 8X	Not supported	
viite speeus	DVD-RAM	Up to 5X		
	CD-R	Up to 24X		
	CD-RW	Up to 24X		
		Triple-layer	Quadruple-layer	
	BD-R	Up to 4X	Up to 4X	
	BD-RE	Up to 4X	Not supported	
		Single-layer	Double-layer	
	BD-ROM	Up to 6X	Up to 6X	
	BD-R	Up to 6X	Up to 6X	
	BD-RE	Up to 6X	Up to 6X	
	DVD-ROM	Up to 8X	Up to 8X	
ead speeds	DVD-R	Up to 8X	Up to 8X	
	DVD-RW	Up to 8X		
	DVD+R	Up to 8X	Up to 8X	



	DVD+RW	Up to 8X	
	BDMV (AACS Compliant Disc)	Up to 6X/2X (Read/Play)	
	DVD-RAM	Up to 5X	
	DVD-Video (CSS Compliant Disc)	Up to 8X/4X (Read/Play)	
	CD-R/RW/ROM	Up to24X	
	CD-DA(DAE)	Up to 20X/10X (Read/Play)	
Access time (typical reads, including settling)	Random	BD-ROM: 205 ms (typical), DVD-ROM: 185 ms (typical), CD-ROM: 165 ms (typical)	
	Full Stroke	BD-ROM: 350 ms (typical), DVD-CD-ROM: 340 ms (typical)	ROM: 345 ms (typical),
	Source	Slimline SATA DC power recepta	cle
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p	
	DC Current	5 VDC -1200 mA typical, 2000 m	A maximum
Environmental conditions (operating - non-condensing)	Temperature	41° to 122° F (5° to 50° C)	
	Relative Humidity	10% to 80%	
	Maximum Wet Bulb Temperature	84° F (29° C)	

HP Slim DVD-ROM Drive			
Height	12.7mm		
Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
<b>Dimensions</b> (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7	7 x 127 mm) without bezel	
Weight (max)	Up to 0.37 lb (170 g) without	bezel	
	DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X	
Read speeds	DVD-ROM	Up to 8X	
-	CD-ROM, CD-R	Up to 24X	
	CD-RW	Up to 24X	
Access time	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)	
(typical reads, including settling)	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)	
	Source	Slimline SATA DC power receptacle	
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p	
	DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum	



<b>Environmental</b> (all conditions non-condensing)	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 80%
	Maximum Wet Bulb Temperature (operating)	84° F (29° C)



#### **Technical Specifications – Memory**

#### **System Memory Support**

The HP ProDesk 600 G1 Business PC supports the 4<sup>th</sup> generation Intel® Core™ processor family. Based on a new PC micro-architecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). Unlike previous generations, the 4<sup>th</sup> generation Intel® Core™ processor includes an Integrated Memory Controller (IMC). The IMC supports DDR3/DDR3L protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC DDR3/DDR3L unbuffered dual in-line memory modules (UDIMM) with a maximum of two DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 1600 MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR3/DDR3L system memory I/O voltage of 1.5V
- · Theoretical maximum memory bandwidth of:
  - 21.3 GB/s in dual-channel mode assuming 1333 MT/s
  - 25.6 GB/s in dual-channel mode assuming 1600 MT/s

#### **Platform Memory Support**

- The Small Form Factor (SFF) and Tower (TWR) platforms support up to four (4) industry-standard DDR3-SDRAM DIMMs.
- The Desktop Mini platform supports up to two (2) industry-standard DDR3-SDRAM SODIMMs.

**CAUTION:** You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

**NOTE:** For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.



Intel® I217LM GbE Netw	ork Connection (integrated)		
Connector	RJ-45		
System Interface	Integrated on PCA		
Controller	Intel I217LM GbE platform LAN co	onnect networking controller	
Memory	24 KB FIFO packet buffer memory	y	
Data rates supported	10/100/1000 Mbps		
IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3ab 802.3az 802.3az		
Bus architecture	PCI Express and SMBus		
Data transfer mode	PCIe-based interface for active state operation (SO state) and SMBus for host and management traffic (Sx low power state)		
Power requirement	Requires 3.3V and 0.9V or just 3.3V with integrated regulators Power consumption 0.733 Watts		
Boot ROM support	Yes		
Network transfer mode	Full-duplex		
Half-duplex (not supported for the 1000BASE-T transceiver)		ne 1000BASE-T transceiver)	
10BASE-T (half-duplex) 10 Mbps			
	10BASE-T (full-duplex) 20 Mbps		
Network transfer rate	100BASE-TX (half-duplex) 100 Mbps		
	100BASE-TX (full-duplex) 200 Mbps		
	1000BASE-T (full-duplex) 2000 Mbps		
Environmental	Operating Temperature:	0° to 85° C	
Environmentat	Operating Humidity:	60% RH	
Management	WOL, auto MDI crossover, PXE, M	uti-port teaming, RSS, Advanced cable diagnostic, WFM 2.0	
Alerting	ASF 2.0 support; AMT 9.0 support		



Wireless LAN Standards	IEEE 802.11a/b/g/n		
Interoperability	Wi-Fi certification		
	BQE certification of the Bluetooth compor	nent	
	CCXv1, v2, v3, v4, v5 CCX certified (Cisco C	lient Extensions)	
	NOTE: WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.		
Frequency Band	802.11b/g/n	2.402-2.482 GHz	
	802.11a/n	4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz	
Antenna Structure	2 transmit; 2 receive (2x2) Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications.		
Data Rates	<ul> <li>802.11b: 1, 2, 5.5, 11 Mbps</li> <li>802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11n: card will support rates for NSS=1 and NSS=2 for RX and TX for 20 and 40 MHz channels. Short and long guard interval shall be supported.</li> </ul>		
Security	<ul> <li>IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>IEEE 802.11i</li> <li>Cisco Certified Extensions, all versions through V5</li> <li>WAPI</li> </ul>		
	NOTE: Check latest software/driver release for updates on supported security f		
Roaming	IEEE 802.11 compliant roaming between band Access Points		
Output Power	<ul> <li>+13.5 dBm minimum</li> <li>Maximum output power must be able to achieve modular regulatory certification per gain of +3dBi at 2.4GHz and +5dBi at 5GHz</li> </ul>		ı peak
	NOTE: Maximum output power may vary by country according to local regulations.		
Power Consumption	Transmit: 2.0 Watts		



	Idla	(IAII AN			
	Idle mode: 250 mW (WLAN associated)				
	Idle mode: 100 mW	(WLAN unassociate	d)		
	Radio off: 75 mW (WLAN unassociated)				
Bluetooth Power	Peak operating: 330	0 mW			
Consumption	Receive: 230 mW				
	USB selective suspe	end: 17 mW			
Power Management	ACPI and PCI Expres 802.11 compliant p Supports USB selec control signals.	ower saving mode	_	tooth component through the L	JSE
Receiver Sensitivity	802.11b				
•		Sensitivity	Rate (Mbps)	Modulation and	
		(dBm)		Coding Rate	
		-95	1	BPSK	
		-93	2	QPSK	
		-91	5.5 11	CCK CCK	
		-88	1 11	LUN	
	802.11a/g			<del>,                                     </del>	
		Sensitivity	Rate (Mbps)	Modulation and	
		(dBm)		Coding Rate	
		-90	6	BPSK - 1/2	
		-89	9	BPSK – 3/4	
		-87	12	QPSK – ½	
		-85	18	QPSK – 3/4	
		-82	24	16 QAM – ½	
		-79	36	16 QAM = 3/2	
		-76	48	64 QAM – 2/3	
		-74	54	64 QAM – <sup>3</sup> / <sub>4</sub>	
	802.11n				
		Sensitivity	Rate (Mbps)	Modulation and	
		(dBm)	Tate (110ps)	Coding Rate	
		-69	150	64 QAM – 5/6	
		-66	300	64 QAM – 5/6	
Form Factors	PCI-Express Half-M	iniCard			
Weight	0.1133 oz (3.212 g)	0.1133 oz (3.212 g)			
Dimensions		in (26.65 x 29.85 x	1.067 mm)		
Operating Voltage	3.3V +/- 9%				
Temperature	Operating: Non-operating:	<b>Operating:</b> 14° to 158° F (-10° to 70° C)			



Humidity	Operating: Non-operating:	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating: Non-operating:	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)

Connector	RJ-45		
System Interface	PCI Express x1		
Controller	Intel® I210 Gigabit Ethernet Controller		
Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers		
Data rates supported	10/100/1000 Mbps		
IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3AB 802.3u 802.3x flow control		
Bus architecture	PCI-E 2.1		
Data path width	X1, 250 MB/s, Bi-directional interface		
Data transfer mode	Bus-master DMA		
Hardware certifications	FCC, B, CE, TUV-c, TUVus Mark Canada and United States, TUV-GS Mark for European Union		
Power requirement	Aux 3.3 V, 3.0 Watts in 1000 base-T and 1.0 Watts in 100 Base-T		
Boot ROM support	Yes 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps		
	10BASE-T (half-duplex) 10 Mbps		
	10BASE-T (full-duplex) 20 Mbps		
Network transfer rate	100BASE-TX (half-duplex) 100 Mbps		
	100BASE-TX (full-duplex) 200 Mbps		
	1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI bus)		



Environmental	Operating Temperature:	32° to 132° F (0° to 55° C)	
Environmentat	Operating Humidity:	85% at 131° F (55° C)	
Management	WOL, PXE, DMI, WFM 2.0		
Intel Centrino Advance-	N 6205 Wireless Network Ir	nterface Connection	
Wireless LAN Standards	EEE 802.11a/b/g/n		
IE	EEE 802.11 e, 802.11i, 802.11d, 802.1	I1d, 802.11h	
Interoperability V	/i-Fi certified (802.11 a/b/g/n WMM, V	NPA, WPA2 and WPS)	
Т	ested with wireless access points fro	m several major manufacturers	
0	S compatible with Microsoft Windows	s, Win7 and XP	
	isco Compatible Extensions Program nd Windows 7	compliant (802.11a/b/g only) with Microsoft Windows XP	
Frequency Band 2	.4 GHz and 5 GHz		
Antenna Structure 2	transmit; 2 receive (2x2)		
Data Rates 8	802.11b: 1, 2, 5.5, 11 Mbps		
8	802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps		
C	802.11n: 66 possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n specification		
	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM		
1	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key sizes of 128bits), TKIP, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPv2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, GTC		
р	Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4) with Microsoft Windows XP only.		
Sub-channels M	Multinational support with frequency bands and channels compliant to local regulations.		
Media Access Protocol C	CSMA/CA (Collision Avoidance) with ACK		
<b>Models</b> In	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) Intel® My Wifi Technology (iPAN)		
<b>Roaming</b> P	rovide seamless roaming between lik	re access points (same frequency band)	
Output Power (for CCK) 1	15 dBm		



Output Power (for OFDM; power varies by data rate)	15 dBm		
Power Consumption	Transmit: 2.3 Watts (average, with one spatial streams)		
	Receive: 1.9 Watts (average with two rece	eive chains)	
	Idle mode: 30mW – 40mW (average)		
	Radio off: 20 mW (max)		
Power Management	ACPI compliant power management 802.11 compliant power saving mode		
Antenna Connections	3 U.FL type connectors, 50 ohm nominal i	impedance	
Range	802.11 a - Typical (@6 Mbps)	600 feet - Outdoor Open Area 150 feet - Indoor, Office environment	
	802.11 b - Typical (@1 Mbps)	1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment	
	802.11 g - Typical (@1 Mbps)	1200 feet - Outdoor Open Area 300 feet - Indoor, Office environment	
Form Factors	Tower & SFF:	PCIe	
Weight	0.013 lb (4.0 g)		
Dimensions	1.1 x 1.2 in (26.8 x 30.0 mm)		
Operating Voltage	3.3V +/- 9%, 1.5V +/- 5%		
Temperature	Operating:       32° to 176° F (0° to 80° C)         Non-operating:       -40° to 176° F (-40° to 80° C)		
Humidity	Operating: Non-operating:	10% to 90% (non-condensing) 5% to 90% (non-condensing)	
	Microsoft Windows XP	Microsoft Windows Win 7	
Configuration Utility	<ul> <li>Microsoft Windows XP Wireless Network Connection Manager</li> <li>Intel PROSet for Microsoft Windows XP (required for Cisco Compatible Extensions support)</li> </ul>	Intel IHV extensions for Win7 available to support Cisco Compatible Extensions	



### **Technical Specifications - Audio**

<b>High Definition Audio</b>		
Туре	Integrated	
HD Stereo Codec	Realtek 2-channel ALC221 codec	
Audio I/O Ports	Front microphone-In (150-K ohm Input Impedance)	
	Rear Line-In/Microphone input (150-K ohm Input Impedance, function is configurable by audio driver)	
	Rear Line-Out* (190 ohms Output Impedance, expects at least a 10-K ohm load)	
	Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm load) Front Microphone/Headphone jack is re-task able to provide Microphone input, line-in or Headphone output to support connecting two headphones to the front of the system. When configured as a second front headphone output, both front headphone outputs are always driven with the same signal.	
	All ports are 3.5mm	
Internal Speaker Amplifier	1.5W amplifier for the internal speaker only. External speakers must be powered externally. Rear Line-in audio port is re-taskable as either Line-in or Microphone-In.	
Multi-streaming Capable	Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks.	
Sampling	8 kHz - 192 kHz	
Wavetable Syntheses	Yes – Uses OS soft wavetable	
Analog Audio	Yes	
# of Channels on Line-Out	Stereo (Left & Right channels)	
Internal Speaker	Yes	
External Speaker Jack	Yes	



HP USB Keyboard		
	Keys	104, 105, 106, 107, 109 layout (depending upon country)
Physical characteristics	Dimensions (L x W x H)	18.12 x 6.47 x 0.96 in (46.03 x 16.43 x 2.44 cm)
	Weight	2 lb (0.9 kg)
	Operating voltage	+ 5VDC ± 5%
	Power consumption	50-mA maximum (with three LEDs ON)
Electrical	System interface	USB Type A plug connector
Electrical	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft® PC 99 - 2001	Functionally compliant
	Keycaps	Low-profile design
	Switch actuation	55-g nominal peak force with tactile feedback
	Switch life	20 million keystrokes (using Hasco modified tester)
Mechanical	Switch type	Contamination-resistant switch membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	6 ft (1.8 m)
	Microsoft PC 99 - 2001	Mechanically compliant
	Acoustics	43-dBA maximum sound pressure level
	Operating temperature	50° to 122° F (10° to 50° C)
	Non-operating temperature	-22° to 140° F (-30° to 60° C)
	Operating humidity	10% to 90% (non-condensing at ambient)
Environmental	Non-operating humidity	20% to 80% (non-condensing at ambient)
	Operating shock	40 g, six surfaces
	Non-operating shock	80 g, six surfaces



	Non-operating vibration	4-g peak acceleration
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	30 in (76.2 cm) on concrete, 16-drop sequence
Approvals	UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, KC	
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS	
Kit contents	Keyboard Installation Guide	
	Warranty Card	Safety and Comfort Guide

HP PS/2 Keyboard			
	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
Physical Characteristics	Dimensions (L x W x H)	18.22 x 6.47 x 1.1 in (46.28 x 16.43 x 2.79 cm)	
	Weight	2 lb (0.9 kg) minimum	
	Operating voltage	+ 5VDC ± 10%	
	Power consumption	50-mA maximum (with three LEDs ON)	
	System interface	PS/2 6-pin mini din connector	
	ESD	CE level 4, 15-kV air discharge	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft PC 99 - 2001	Functionally compliant	
Electrical	Keycaps	Low-profile design	
	Switch actuation	55-g nominal peak force with tactile feedback	
	Switch life	20 million keystrokes (using Hasco modified tester)	
	Switch type	Contamination-resistant switch membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
Environmental	Acoustics	50-dBA maximum sound pressure level	



	Operating temperature	32° to 104° F (0° to 40° C)
	Non-operating temperature	-22° to 149° F (-30° to 65° C)
	Operating humidity	15% to 80% (non-condensing at ambient)
	Non-operating humidity	15% to 90% (non-condensing at ambient)
	Operating shock	N/A
	Non-operating shock	65 inch 2.9 ms, six surface; 30g 266 inch/second; 50g 266 inch/second six surface
	Operating vibration	2-g peak acceleration
	Non-operating vibration	Starting at 5 Hz, vary the frequency of vibration from 5 to 500 Hz and back to 5 Hz at a Logarithmic sweep rate of 1 octave per minute.
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	29.93 in (76 cm) on concrete, 16-drop sequence
Approvals	CUL, ICES-003 Class B, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC	
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS	

HP USB Smart Card (CCID) Keyboard			
	Protects against unauthorize	Protects against unauthorized access with smart card technology	
	_	Delivers even greater security when combined with a HP Client Security smart card and the HP Client Security Software	
	Combination of username ar	nd password or pin with a smart card or security token	
Key Benefits:	Secures online transactions	using digital signatures and certificates	
	Conforms to industry standa	ards for ease of setup and use	
	<ul> <li>Delivers long product life and quiet operation with high-impact materials and lubricated keys</li> </ul>		
	Spill drain feature		
	Keys	104, 105, 106, 107, 109 layout (depending upon country	
Physical Characteristics	Form factor	USB basic smart card keyboard	
	Colors	Carbonite/Silver	
	Dimensions (H x W x D)	18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)	



	Weight	2 lb (0.9 kg) minimum	
	Operating voltage	+ 5VDC ± 5%	
	Power consumption	100-mA maximum (with four LEDs ON)	
Electrical	System interface	USB Type A plug connector	
Electricat	ESD	CE level 4, 15-kV air discharge	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft PC 99 - 2001	Functionally compliant	
	Languages	30+ available	
	Keycaps	Standard design	
	Switch actuation	55 g nominal peak force with tactile feedback	
Mechanical	Switch life	20 million keystrokes (using Hasco modified tester)	
	Switch type	Contamination-resistant membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	43-dBA maximum sound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)	
	Non-operating temperature	-22° to 140° F (-30° to 60° C)	
	Operating humidity	10% to 90% (non-condensing at ambient)	
	Non-operating humidity	20% to 80% (non-condensing at ambient)	
Environmental	Operating shock	40 g, six surfaces	
	Non-operating shock	80 g, six surfaces	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	4-g peak acceleration	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence	

### **Technical Specifications - Input/Output Devices**

	Support	All ISO 7816 smart cards	5
	Interface	Reads from and writes to all ISO7816-1, 2, 3, 4 memory and microprocessor smart cards (T=0, T=1)	
	Chipset	SCM STCII	
	Standard APIs supported	PC/SC, EMV2000, SET	
		USB Port	
	Parage	Short circuit detection (preader)	protects smart card and
	Power	Power supply compliant 60 mA)	with ISO7816 and EMV (5V,
		Supports 3-V and 5-V ca	Supports 3-V and 5-V cards
SmartCard Function	Power consumption	100-mA maximum draw	1
		From card	9600 bps to 330,000 bps
	Communication	From computer	12 Mbps (USB transfer speed)
	Landing mechanism	Contact device	Friction contact
		Card insertions rating	Up to 100,000 insertion cycles
	Interface modes	CCID protocol	
	Reader performance interface	USB connection	
	Electro magnetic standards	Europe	2004/108/EC
	Electro-magnetic standards	USA	USAFCC part 15
Approvals	CE-Mark, UL, CSA, FCC, CE Mark, TU	V, TUV GS, VCCI, BSMI, C-Tick	, MIC, EMV2000, USB-IF
Ergonomic Compliance	ISO 9241-4, TUVGS		
Kit Contents	Keyboard, I/O Security and Documentation CD, warranty card		

### **HP USB PS/2 Washable Keyboard**



### Technical Specifications - Input/Output Devices

Physical Characteristics	Keys	104 (US) Layout, 105 (EU) layout – depending upon country	
	Dimensions (L x W x H)	17.67x 6.62 x 1.38 in (449 x 168 x 35 mm)	
	Weight	1.7 lb (0.77 kg) minimum	
	Operating voltage	+ 5VDC ±5%	
	Power consumption	50-mA maximum (with three LEDs ON)	
Electrical	System interface	USB Type A plug connector	
ctectricat	ESD	CE level 4, 15-kV air discharge	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft PC 99 - 2001	Functionally compliant	
	Keycaps	Stepped -profile design	
	Switch actuation	55-g nominal peak force with tactile feedback	
	Switch life	20 million keystrokes	
Mechanical	Switch type	Contamination-resistant switch membrane	
Mechanical	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	7 ft (2.2 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	43-dBA maximum sound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)	
	Non-operating temperature	4° to 149° F (-20° to 65° C)	
	Operating humidity	10% to 95% (non-condensing at ambient)	
	Non-operating humidity	0% to 95% (non-condensing at ambient)	
Environmental	Operating shock	40 g, six surfaces	
Environmentat	Non-operating shock	80 g, six surfaces	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	4-g peak acceleration	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence	
perating system support	Windows® 7, Windows Vista, Wi	ndows XP Professional	
Approvals	UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1, IP66/NEMA4X		
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS		

### **HP Wireless Keyboard and Mouse**

Keyboard	Dimensions (H x L x W)	1.09 x 18.1 x 6.47 in (27.87 x 460.3 x 164.3 mm)
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		4 04 11 (000 )	
	Weight – Without Two AA Alkaline Batteries	1.94 lb (880 g)	
Mouse	Dimensions (H x L x W)	1.46 x 4.53 x 2.47 in (37 x 115 x 62.9 mm)	
	Weight – Without Two AA Alkaline Batteries	0.15 lb (67 g)	
Receiver	Dimensions (H x L x W)	0.33x 1.79 x 0.72 in (8.4 x 45.5 x 18.4 mm)	
	Weight	0.21 oz (5.9 g)	
	Range	32.8 ft (10 m)	
System Requirements	64*, Windows Vista or Window Available USB port for the rece CD-ROM Drive * Not all features are available upgraded and/or separately pu	Windows 10, Windows 8, Windows 7 Professional Edition 32*, Windows 7 Professional Edition 64*, Windows Vista or Windows XP  Available USB port for the receiver  CD-ROM Drive  * Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows functionality. See http://www.microsoft.com.	
Approvals	Product Safety	UL; CSA /TUV (Europe only); CE Mark; CB Report	
	Ergonomics	ANSI; ISO (Europe only); GS Mark (Germany only)	
	EMC	FCC; CE; ACA (-tick); BSMI; KC ; VCCI	
	CE Mark	EN 55022:2010; EN 55024; EN 301489-1; EN 61000	
	Design Guidelines for PCs	PC 99 – connector overmold colors; PC 2001 – full functionality	
	Telecom	All local telecom requirements and approvals for intended markets	
	USA	FCC Title 47 CFR, Par 15, Subpart C; other local requirements	
	Country Support	US, Belgium, Switzerland, Spain, Denmark, Netherlands, France, Germany, Italy, Portugal, Sweden, Norway, Finland, UK, Poland, Czech Republic, Turkey, Greece, Austria, Bulgaria, Cyprus, Estonia, Hungary, Ireland, Latvia, Lithuania, Luxemburg, Malta, Romania, Slovakia, Slovenia, Vietnam, HK, Australia, NZ, Malaysia, Singapore, Indonesia, Philippines, Thailand, Canada, China, Japan, Korea, Taiwan, India, Venezuela, Ecuador, Russia, Ukraine, Israel, Croatia,	



		United Arab Emirates, Peru, Brazil, Chile, Argentina, Mexico, South Africa, and up to 193 countries worldwide.
Environmental	Keyboard contains 25% post-consumer recycled plastic material	
Encryption	128bit AES Encryption	

HP PS/2 Mouse			
<b>Dimensions</b> (H x L x W)	1.46 x 2.48 x 4.53 in (3.70 x 6.29	1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)	
Weight	3.53 oz (100g; +10g/- 5 g)	3.53 oz (100g; +10g/- 5 g)	
	Operating temperature	-32° to 104°F (0° to 40° C)	
	Non-operating temperature	-4° to 140°F (-20° to 60° C)	
Environmental	Operating humidity	10% to 90% (non condensing at ambient)	
	Non-operating humidity	10% to 90% (non condensing at ambient)	
	Operating shock	40 g, 6 surfaces	
	Non-operating shock	80 g, 6 surfaces	
	Operating vibration	2 g peak acceleration	
	Non-operating vibration	4 g peak acceleration	
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face	
	Operating voltage	5 VDC ± 10%	
	Power consumption	100mA	
Plantwind	System consumption	PS/2 mini-din connector	
Electrical	ESD	CE level 4, 15 kV air discharge	
	EMI-RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft PC99 - 2001	Functionally compliant	



	Resolution	800 DPI
	Tracking speed	10 in/s (25.4 cm/s) maximum
	Acceleration	±15%
	Switch actuation	65±20 gf
Mechanical	Switch life	3,000,000 operations (using Hasco modified tester)
	Switch type	Low force micro-switches
	Tracking mechanism life	80 km
	Cable length	6 ft (1.8 m)
	Microsoft PC99 - 2001	Mechanically compliant
	Width	6 mm
	Diameter	22.5 ± 0.2 mm
Scroll wheel	Maximum rotation force	50 gf-cm
Scroll wheel	Switch type	Light force micro-switch
	Switch life	1 million operations
	Mechanical life	Minimum 200,000 revolutions
Regulatory Approvals	UL/cUL, FCC, CE Mark, TUV/GS, VCCI, KCC, BSMI, C-Tick	

HP USB Mouse		
Dimensions (H × L × W)	1.5 x 4.5 x 2.5 in (3.7 x 11.5 x 6.3 cm)	
Weight	0.22 lb (0.10 kg)	
Cable length	70.9 in (180 cm)	
System requirements	Available USB port	

HP USB 1000dpi Laser Mouse		
Dimensions (H x L x W)	1.47 x 4.53 x 2.47 in (37.3 x 114.97 x 62.86 mm)	
(II X E X W)		



Weight	3.360 oz (102g)	3.360 oz (102g)		
Cable length	70.9 in (180 cm)	70.9 in (180 cm)		
System requirements	Available USB port	Available USB port		
	Operating Temperature	32° to 104° F (0° to 40° C)		
Environmental	Non-operating Temperature	-4° to 140° F (-20° to 60° C)		
	Operating Humidity	10% to 90% (non-condensing at ambient)		
	Resolution	1000dpi		
Mechanical	Tracking Speed	45 cm/sec		
	Cable Length	70.9 in (180 cm)		

HP USB PS/2 Washable Mouse				
<b>Dimensions</b> (H x L x W)	1.56 x 2.44 x 4.61 in (3.95 x 6.2	1.56 x 2.44 x 4.61 in (3.95 x 6.21 x 11.7 cm)		
Weight	4.44 oz (126 g)	4.44 oz (126 g)		
	Operating temperature	-32° to 104°F (0° to 40° C)		
	Non-operating temperature	-4° to 140°F (-20° to 60° C)		
	Operating humidity	10% to 90% (non-condensing at ambient)		
	Non-operating humidity	10% to 90% non-condensing		
Environmental	Operating shock	40 g, 6 surfaces		
	Non-operating shock	80 g, 6 surfaces		
	Operating vibration	2 g peak acceleration		
	Non-operating vibration	4 g peak acceleration		
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face		
Floatwicel	Operating voltage	5 VDC ± 10%		
Electrical	Power consumption	100mA		



	System consumption	PS/2 mini-din connector or USB	
	ESD	CE level 2 8 kV air discharge	
	EMI-RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft PC99 - 2001	Functionally compliant	
	Resolution	1000 ± 20% DPI	
	Tracking speed	14 in/s ( 35.56 cm/s) maximum	
	Acceleration	2 g	
	Switch actuation	70 g nominal peak force	
Mechanical	Switch life	3,000,000 operations (using Hasco modified tester)	
	Switch type	Low force micro-switches	
	Tracking mechanism life	8.8 ft total 70 cm+ 2m extension	
	Cable length	Mechanically compliant	
	Microsoft PC99 - 2001	1000 ± 20% DPI	
	Width	6 mm	
	Diameter	1 in (25.4 mm)	
Scroll wheel	Maximum rotation force	48 rats/sec	
Scrott wheet	Switch type	Light force micro-switch	
	Switch life	3 million operations	
	Mechanical life	Minimum 200,000 revolutions	
Regulatory Approvals	FCC, CE Mark, ICES-003-B, IP66/NEMA4X		



#### Technical Specifications – Power

#### **Unit Environment and Operating Conditions**

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range Operating: 50° to 95° F (10° to 35° C)\*

Non-operating: -22° to 140° F(-30° to 60° C)

Relative Humidity Operating: 10% to 90% (non-condensing at ambient)

Non-operating: 5% to 95% (non-condensing at ambient)

Maximum Operating: 10,000 ft (3048 m) Non-operating: 30,000 ft (9144 m) Altitude (unpressurized)

<sup>\*</sup>Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply	DM	SFF	TWR
Standard Efficiency	65W active PFC 87% efficient 89% average efficiency at 230V 88% average efficiency at 115V	240W active PFC	320W active PFC
	N/A	240W active PFC	320W active PFC
80 PLUS Gold		87/90/87% efficient at 20/50/100% load (115V)	87/90/87% efficient at 20/50/100% load (115V)
		89/91/90% efficient at 20/50/100% load (230V)	89/92/90% efficient at 20/50/100% load (230V)
	N/A	240W active PFC	320W active PFC
80 PLUS Platinum		90/92/89% efficient at 20/50/100% load (115V)	90/92/89% efficient at 20/50/100% load (115V)
		90/93/91% efficient at 20/50/100% load (230V)	90/94/91% efficient at 20/50/100% load (230V)
Operating Voltage Range	90 - 264 VAC	90 - 264 VAC	90 - 264 VAC
Rated Voltage Range	100 - 240 VAC	100 - 240 VAC	100 - 240 VAC
Rated Line Frequency	50/60 Hz	50/60 Hz	50/60 Hz
Operating Line Frequency Range	47 – 63 Hz	47 – 63 Hz	47 – 63 Hz
Rated Input Current	N/A	4A	5.5A



5.5A

### Technical Specifications - Power

TBA

**Rated Input Current** with Energy Efficient\*

Power Supply

DC Output +19.5V

**Current Leakage** (NFPA 99: 2102)

Less than 500 microamps of leakage current at 120 Vac with the ground wire disconnected, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or

4A

that contact patients in normal use. Per section 10.3.5.1.

Less than 100 microamps of leakage current at 120 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a patient care

facility or that contact patients in normal use. Per section 10.3.5.1.

Power Supply Fan 92=>70mm variable speed 92mm variable speed N/A Power cord length N/A 6.0 ft. (1.83 m) 6.0 ft. (1.83 m)

**External Power Adapter** 

N/A N/A **Dimensions** 2.2 x 1.2 x 4.5 in

55 x 30 x 113.5 mm

12 ft. 8 in N/A N/A **Total Cord Length** 



### Technical Specifications – Weights & Dimensions

### **Weights & Dimensions**

(configured with 1 HDD & 1 ODD; DM configured with 1 HDD only)

	<u>DM</u>	<u>SFF</u>	<u>TWR</u>
Chassis (W x H x D)	6.9 x 1.3 x 7.0 in	13.3 x 3.95 x 14.9 in	6.7 x 15.7 x 17.4 in
	175 x 34 x 177 mm	338 x 100 x 379 mm	170 x 399 x 442 mm
System Volume	62.79 cu in	782.7 cu in	1828 cu in
	1.05 L	12.8 L	30 L
System Weight	2.9 lb	16.7 lb	20.5 lb
	1.3 kg	7.6 kg	9.3 kg
Max Supported	77.0 lb	77.0 lb	77.0 lb
Weight (desktop orientation)	35.0 kg	35.0 kg	35.0 kg
Stand Dimensions	.77x 4.6 x 6.3 in 19.5 x 117 x 160 mm Weight: 47g/ .1 lbs.	1.1 x 7.0 x 7.9 in 29 x 178 x 200 mm	N/A
Packaging	7.8 x 11.4 x 19.7 in	9.0 x 19.7 x 23.4 in	11.6 x 19.7 x 23.2 in
	198 x 290 x 500 mm	229 x 500 x 594 mm	295 x 500 x 590 mm
Shipping Weight	9.0 lb.	17.9 lb	28.8 lb
	4.1 kg	8.1 kg	13.1 kg
Palletization Profile	8-units per layer	4-units per layer	4-units per layer
	10/12 layer max	10-layer max.	8-layer max.
	80/96 per pallet	40-units per pallet	32-units per pallet
	47.126 x 39.291 x 99.252 in	47.126 x 39.291 x 88.858 in	47.126 x 39.291 x 98.622 in
	(including pallet)	(including pallet)	(including pallet)

(Dependent on 40-Ft Stnd. Sea Container or 40-Ft High-cube Sea Container is used)

#### Technical Specifications – Miscellaneous Features

#### **Management Features**

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
   Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel Wired for Management support; industry wide initiative to make Intel architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

### **Serviceability Features**

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
  - Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
    - 2 processor thermal protection activated
    - 3 processor not installed
    - 4 power supply failure
    - 5 -- memory error
    - 6 video error
    - 7 PCA failure (ROM detected failure prior to video)
    - 8 invalid ROM, bootblock recovery mode
    - 9 system not fetching code
    - 10 system hang while loading an option ROM
- HP PC Hardware Diagnostics UEFI:
  - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification



#### Technical Specifications – Miscellaneous Features

Additional Features	Description
---------------------	-------------

**Towerable Orientation** Product can be oriented as either a desktop or a tower

Implementation of the industry standard ATA Security feature set. When enabled, it **Drive Lock**prevents software access to user data on the drive until one or two user-defined

passwords are provided.

DPS Access through F10 Setup during Boot

A diagnostic hard drive self test. It scans critical physical components and every sector

of the hard drive for physical faults and then reports any faults to the user  $% \left\{ 1\right\} =\left\{ 1$ 

Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and

needs to be replaced

The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain

types of failures

SMART Technology (Self-Monitoring, Analysis and Reporting Technology)

Allows hard drives to monitor their own health and to raise flags if imminent failures

were predicted

SMART I - Drive Failure Prediction

**Drive Protection System** 

Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry count By avoiding actual hard drive failures, SMART hard drives act as "insurance" against

**SMART II - Off-Line Data Collection** 

unplanned user downtime and potential data loss from hard drive failure

SMART III - Off-Line Read Scanning with

Defect Reallocation

IOEDC: I/O Error Detection Circuitry

Detects errors in Read/Write buffers on HDD cache RAM

SMART IV - End-to-End CRC for hard

drives

Interface in F10 setup provides confirmation of SMART IV support.



### Technical Specifications – Environmental Data

#### **Environmental Data**

Eco-Label Certifications & Declarations This product series has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- US ENERGY STAR®
- IT ECO declaration
- EPEAT® Gold where HP registers commercial desktop products. See <a href="http://www.epeat.net">http://www.epeat.net</a> for registration status in your country.

## System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Model	<b>Energy Consumption</b> (typically configured)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
DM	Normal Operation (Short idle)	8.10 W	8.19 W	7.85 W
	Normal Operation (Long idle)	5.99 W	6.16 W	5.96 W
	Sleep	1.67 W	1.57 W	1.65 W
	Off	1.03 W	1.0 W	1.06 W
SFF	Normal Operation (Short idle)	16.44 W	16.22 W	16.12 W
	Normal Operation (Long idle)	14.15 W	13.19 W	14.80 W
	Sleep	1.44 W	1.52 W	1.43 W
	Off	0.58 W	0.64 W	0.57 W
TOWER	Normal Operation (Short idle)	18.28 W	19.36 W	18.83 W
	Normal Operation (Long idle)	17.94 W	16.83 W	17.79 W
	Sleep	1.47 W	1.57 W	1.46 W
	Off	0.54 W	0.63 W	0.53 W

NOTE: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP personal computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Model	Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
DM	Normal Operation (Short idle)	28 BTU/hr	28 BTU/hr	27 BTU/hr
	Normal Operation (Long idle)	20 BTU/hr	21 BTU/hr	20 BTU/hr
	Sleep	6 BTU/hr	5 BTU/hr	6 BTU/hr
	Off	4 BTU/hr	3 BTU/hr	4 BTU/hr
SFF	Normal Operation (Short idle)	56 BTU/hr	55 BTU/hr	55 BTU/hr
	Normal Operation (Long idle)	48 BTU/hr	45 BTU/hr	50 BTU/hr
	Sleep	5 BTU/hr	5 BTU/hr	5 BTU/hr
	Off	2 BTU/hr	2 BTU/hr	2 BTU/hr



### Technical Specifications – Environmental Data

TOWER	Normal Operation (Short idle)	63 BTU/hr	66 BTU/hr	64 BTU/hr
	Normal Operation (Long idle)	61 BTU/hr	58 BTU/hr	61 BTU/hr
	Sleep	5 BTU/hr	5 BTU/hr	5 BTU/hr
	Off	2 BTU/hr	2 BTU/hr	2 BTU/hr

\*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
Model	(Typically configured)		
DM	Idle	3.6	25
	Fixed Disk (random writes)	3.6	24
SFF	Idle	3.6	26
	Fixed Disk (random writes)	3.6	26
TOWER	Idle	3.6	26
	Fixed Disk (random writes)	3.6	26

# Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 10 externally accessible USB ports
- · DIMM memory slots
- 1 PCI Express x16 graphics slot
- 3 PCI Express x1 accessory slot
- 2 2.5" internal storage drive bay
- 1 2.5" internal storage drive bay
- 1 3.5" Media Card Reader bay
- 1 external slim optical drive bay
- 5.25" Half height optical drive bay

#### Spare Par Support

**Spare Part** Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

### Batteries

The battery in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the 1ppm by weight
- Cadmium greater than 20ppm by weight

Battery Size CR2032 (coin cell)

Battery Type Lithium

#### Model Additional Information

DM

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.

#### Technical Specifications - Environmental Data

- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the <gold> level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 16% post-consumer recycled plastic (by wt.)
- This product is 91.3% recycle-able when properly disposed of at end of life.

#### **Packaging Materials**

- External:
  - PAPER/Corrugated 852 g
- Internal:
  - PLASTIC/EPE-Expanded Polyethylene 38 g
  - PLASTIC/Polvethylene low density
     13 g
  - PLASTIC/Polypropylene 8 g
- The plastic packaging material contains at least 9.5 % recycled content.
- The corrugated paper packaging materials contains at least 42.3 % recycled content.

**SFF** 

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive -2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold where HP registers commercial desktop products. See <a href="http://www.epeat.net">http://www.epeat.net</a> for registration status in your country.
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 14.8% post consumer recycled plastic (by wt.)
- This product is 94.1% recyclable when properly disposed of at end of life.

#### **Packaging Materials**

- External:
  - PAPER/Corrugated 2300 g
- Internal:
  - o PLASTIC/EPE-Expanded Polyethylene 110 g
  - o PLASTIC/Polyethylene low density 56 g
  - PLASTIC/Polypropylene 15 q
- The PAPER/Corrugated material contains at least 38.38% recycled content.
- The PLASTIC/EPE-Expanded Polyethylene material contains at least 60.4% recycled content.
- The PLASTIC/Polyethylene low density material contains at least 60.4% recycled content.
- The PLASTIC/Polyethylene packaging material contains at least 60.4 % recycled content.

#### **TOWER**

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive -2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold where HP registers commercial desktop products. See <a href="http://www.epeat.net">http://www.epeat.net</a> for registration status in your country.
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 15% post consumer recycled plastic (by wt.)



### Technical Specifications – Environmental Data

This product is 95.5% recyclable when properly disposed of at end of life.

#### **Packaging Materials**

- External:
  - o PAPER/Corrugated 2280 g
- Internal:
  - PLASTIC/EPE (Expanded Polystyrene) 144 q
  - o PLASTIC/Polyethylene low density 40 g
  - PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated material contains at least 53.5% recycled content.
- The PLASTIC material contains at least 60.42% recycled content.

#### **RoHS Compliance**

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. By July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).

#### **Material Usage**

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at:

http://www.hp.com/hpinfo/qlobalcitizenship/environment/supplychain/gen\_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
- ALL FORM FACTORS ARE UL CERTIFIED

#### **Packaging**

HP follows these guidelines to decrease the environmental impact of product packaging:

 Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.



#### Technical Specifications – Environmental Data

- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

#### End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information For more information about HP's commitment to the environment:

**Global Citizenship Report** 

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

**Eco-label certifications** 

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html



After-Market Options (availability may vary by region)

Communication Devices	DM	SFF/TWR	Part Number
Intel Ethernet I210 – T1 Gbe NIC		X	E0X95AA
Intel 6205 802.11 a/b/g/n PCIe x1 NIC		Χ	E0X93AA
HP WLAN 802.11 a/g/n 2x2 DualBand PCIe x1 Card		Χ	J5C51AA
Graphics Solutions	DM	SFF/TWR	Part Number
AMD Radeon HD 8350 Graphics (PCIe x16)		Х	E1C63AA
AMD Radeon HD 8490 Graphics Card		X	E1C64AA
Nvidia NVS 310 Graphics (PCIe x16)		Χ	A7U59AA
Nvidia NVS 315 Graphics (PCIe x16)		Χ	E1C65AA
HP USB Graphic Adapter		Χ	NL571AA
HP DisplayPort Cable Kit	Χ	Χ	VN567AA
HP DisplayPort To Dual Link DVI-D Adapter	Χ	X	NR078AA
HP DisplayPort To DVI-D Adapter	Χ	Χ	FH973AA
HP DisplayPort to HDMI Adapter	Χ	Χ	BP937AA
HP DisplayPort to HDMI 1.4 Adapter	Χ	Χ	K2K92AA
HP DisplayPort to VGA Adapter	Χ	Χ	AS615AA
HP DMS-59 to Dual DVI Cable		Χ	DL139A
HP DMS-59 to Dual DisplayPort Adapter		Χ	XP688AA
Data Storage Drives and Accessories		SFF/TWR	Part Number
HP Desktop Mini 500-GB Hard Disk Drive	Х		K9Q82AA
HP Desktop Mini DVD-Writer ODD Module ()	Х		K9Q83AA
HP Desktop Mini I/O	Х		K9Q84AA
HP Desktop Rack Mount Module	Х		G1K21AA
HP Desktop Mini Security/Dual Vesa Sleeve	Χ		G1K22AA
HP Desktop 65w Mini Power Supply Kit	Χ		TBD
HP Desktop 90w Mini Power Supply Kit	Χ		TBD
HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		Χ	QK554AA
HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		Χ	QK555AA
HP 128-GB SATA 3.0Gb/s Solid State Drive	Χ	Χ	QV063AA
HP 128-GB SED Opal 2 Solid State Drive	Χ		G1K24AA
HP 160-GB SATA 3.0Gb/s Solid State Drive	Χ	X	QV064AA*
HP 500-GB SATA 3.0Gb/s Solid State Hybrid Drive	Χ	Χ	E1C62AA
HP Slim Removable SATA Hard Drive Enclosure (frame & carrier)		Χ	C1N41AA
HP Slim Removable SATA Hard Drive Enclosure (carrier only)		Χ	E3F39AA
HP Chassis (1bay) Security Kit		TWR only	AR639AA
HP Desktop Mini 500GB HDD/ I/O Expansion Module *Not available in all regions.	Χ		K9Q82AA
Input Devices	DM	SFF/TWR	Part Number
HP USB Keyboard	Х	х	QY776AA
HP USB Gray Keyboard	X	X	B6B64AA



After-Market Options (availability may vary by region)			
HP USB Smart Card (CCID) Keyboard	Х	Х	BV813AA
HP USB Keyboard and Mouse Kit	Χ	X	B1T09AA
HP USB Washable Keyboard	Χ	X	VF097AA
HP USB and PS/2 Washable Mouse	Χ	X	BM866AA
HP USB and PS/2 Washable Keyboard and Mouse Kit	Χ	Χ	BU207AA
HP USB Grey Mouse	Χ	X	K7W54AA
HP PS/2 Mouse		X	QY775AA
HP USB Mouse	Χ	Χ	QY777AA
HP USB 1000dpi Laser Mouse	Χ	Χ	QY778AA
HP USB Gray Mouse	Χ		K7W54AA
HP Wireless Keyboard and Mouse Combination*	Χ	X	QY449AA
HP USB Antimicrobiall Keyboard and Mouse (China Only)	Χ	X	K7X25AA
HP Desktop Mini I/O Expansion Module	Χ		K9Q84AA
*Keyboard contains 25% post-consumer recycled plastic material			
System Memory	DM	SFF/TWR	Part Number
HP 4GB DDR3-1600 (PC3-12800) DIMM		Χ	B4U36AA
HP 8GB DDR3-1600 (PC3-12800) DIMM		Χ	B4U37AA
HP 4GB DDR3-1600 (PC3-12800) SODIMM	Χ		B4U39AA
HP 8GB DDR3-1600 (PC3-12800) SODIMM	Χ		B4U40AA
Multimedia Devices	DM	SFF/TWR	Part Number
HP Slim DVD-ROM Drive		Х	VP033AA
HP Slim SuperMulti DVD Writer Drive		Х	QS209AA
HP USB HD 720P v2 Business Webcam	Х	X	D8Z08AA
HP Business Headset	Х	X	QK550AA
HP USB Business Speakers	Х	Χ	D9J19AA
	Х		K9Q83AA
Domoushie Media Chausas	DM	SFF/TWR	Part Number
Removable Media Storage	ויוט	-	
HP 14-n-1 Media Card Reader (available Dec. 2013)		Х	TBD
Security Devices	DM	SFF/TWR	Part Number
HP Solenoid Lock and Hood Sensor (SFF)		SFF only	E0X97AA
HP Solenoid Lock and Hood Sensor (TWR)		TWR only	E0X96AA
HP SFF Wall Mount/Security Sleeve		SFF only	VN570AA
HP UltraSlim Cable Lock	Χ	Χ	H4D73AA
HP Desktop Mini Security/Dual VESA Sleeve	Χ		G1K22AA
Stands and Accessories	DM	SFF/TWR	Part Number
HP Integrated Work Center – Desktop Mini / Thin Client (IWCdm)	Х		
HP Integrated Work Center Stand (SFF)		SFF only	QP897AA



## After-Market Options (availability may vary by region)

HP SFF Tower Stand		SFF only	VN569AA
HP DM Chassis Tower Stand	Х		G1K23AA
HP 600/800 Tower Bezel Kit		TWR only	E1C66AA
HP 800/600 SFF Bezel Kit		SFF only	E3F27AA
HP Serial Port Adapter (RS-232 compatible)		X	PA716A
HP Parallel Port Kit		X	KD061AA
Belkin USB to Serial Adapter	X		EM449AA
HP Desktop Mini Rack Mount Module	Χ		G1K21AA

NDesk Software (E-Delivery)	Part Number
LANDesk Management Suite License - 1-499 Nodes E-Delivery	QY369AAE
LANDesk Management Suite License - 500-999 Nodes E-Delivery	QY370AAE
LANDesk Management Suite License - 1000-1999 Nodes E-Delivery	QY371AAE
LANDesk Management Suite License - 2000-4999 Nodes E-Delivery	QY372AAE
LANDesk Management Suite License - 5000-9999 Nodes E-Delivery	QY373AAE
LANDesk Security Suite License E-Delivery	QY379AAE
LANDesk Management Suite 1 Year Maintenance - 1-499 Nodes E-Delivery	HZ825AAE
LANDesk Management Suite 1 Year Maintenance - 500-999 Nodes E-Delivery	HZ826AAE
LANDesk Management Suite 1 Year Maintenance - 1000-1999 Nodes E-Delivery	HZ827AAE
LANDesk Management Suite 1 Year Maintenance - 2000-4999 Nodes E-Delivery	HZ828AAE
LANDesk Management Suite 1 Year Maintenance - 5000-9999 Nodes E-Delivery	HZ829AAE
LANDesk Security Suite 1 Year Subscription	HZ830AAE
LANDesk Patch Management 1 Year Subscription - 1-499 Nodes E-Delivery	HZ831AAE
LANDesk Patch Management 1 Year Subscription - 500-999 Nodes E-Delivery	HZ832AAE
LANDesk Patch Management 1 Year Subscription - 1000-1999 Nodes E-Delivery	HZ833AAE
LANDesk Patch Management 1 Year Subscription - 2000-4999 Nodes E-Delivery	HZ834AAE
LANDeskPatch Management 1 Year Subscription - 5000-9999 Nodes E-Delivery	HZ835AAE
LANDeskPatch Management 1 Year Subscription - 5000-9999 Nodes E-Delivery	HZ835AAE



#### **HP ProDesk 600 G1 Business Series Desktop**

## QuickSpecs

After-Market Options (availability may vary by region)

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### After-Market Options (availability may vary by region)

#### Change Log

From v1 to v2

April 23, 2014 - From Version 1.9 February to 2.0 April 2014

#### Removed

Remove all instances of:

- Supports Intel® vProTM Technology
- Intel® Stable Image Platform Program (SIPP)

#### May 5, 2014 - From Version 2.0 to 2.1

#### Changed

Multiple changes including adding HP Integrated Work Center – Desktop Mini / Thin Client (IWCdm)

#### June 2, 2014- From Version 2.1 to 2.2

#### Changed

Processors, storage options, environmental data

#### July 17, 2014 - From Version 2.2 to 22

#### **Upgrade**

Change the version so it would match the PB

#### July 18, 2014 - From Version 22 to 23

#### Update

update the TPM entry under the Security header

Added two Wlan cards Networking/communications

#### August 07, 2014 - From Version 23 to 24

#### Changed

Describe what changed

#### September 29, 2014 - From Version 24 to 25

#### **Addition**

Added under Graphics "AMD Radeaon R9" section, and under "Networking" added the section "HP WLAN 802.11 a/b/g/n 2x2 Dual Band PCIe x1 WLAN/Bluetooth Card"

#### October 14, 2014 From Version 25 to 26

#### Changed

Change the values in the chart Environmental Data

#### October 15, 2014 From Version 26 to 27

#### Change

Change the values in the chart Environmental Datafor DM, SFF and Tower

#### October 29, 2014 From Version 27 to 28

#### Remove

Remove windows 7 ultimate and home

#### November 12, 2014 From Version28 to version 29

#### Changes

Several changes from Javier Lazaro,

#### Addition

Added a new option of mouse "HP USB Gray Mouse"

#### Change

Change the weight for DM in the "Max Supported Weigth"

#### Added

2 new sections for Hard Drive and Solid State

#### January 21, 2015 From version 29 to version 30

Added

Added a note about Current Leakage, under POWER

January 28, 2015 from v30 to v31



#### After-Market Options (availability may vary by region)

#### Added

AMD Radeon R7 240 2GB FH PCIe x16 GFX under Graphics to SFF/MT

HP DisplayPort To HDMI 1.4 Adapter under Graphics

(with 3.5" adapter when needed) to 120 GB SATA 2.5 Non-SED SSD and 180 GB SATA 2.5 Non-SED SSD to Sff/MT (with 3.5" adapter when needed) to 180 GB SATA 2.5 Opal2 SED SSD and 120 GB SATA 2.5 Opal2 SED SSD to SFF/MT 512 GB SATA 2.5 SSD (Non-SED) only for SFF

HP USB Antimicrobial Keyboard under Graphics

**Under Slots added** 

3 ea.

2.5" low profile

6.6" length

10W max. power

and (v2.0) to PCI Express x1

1 ea.

2.5" low profile

6.6" length

35W max. power

(v3.0) to PCI Express x16

AMD Radeon R7 240 2GB PCIe x16

HP DisplayPort to HDMI 1.4 Adapter, and HP USB Antimicrobiall Keyboard and Mouse (China Only) under Graphics

#### Removed

Intel® Pentium® G3250T from Sff/MT

Intel® Pentium® G3450T From Sff/MT

#### Changed

From Bays

3.5" internal storage drive 1 to 2 in TWR

From Graphics/Video API Support, OpenGL 4.3, from .0 to .3

#### February 23, 2015 from v31 to v32

#### Added

Processor support up to 84W (TWR/SFF), 35W (DM) added to "At a glance"

#### Removed

Removed chart HP 160 GB Solid State Drive

#### Changed

Change the values in the chart "Slots" for SFF and TWR

March 16, 2015 from v32 to v33

#### Added

Added a new value to "Power Supply"

March 16, 2015 from v33 to v34

#### Added

Added a new value to the Supported Display Resolution and Refresh Rates

March 24, 2015 from v34 to v35

#### Changed

Change the chart HP 500-GB 7200 RPM SATA 2.5" Self-Encrypting (SED) Hard Disk Drive

April 6, 2015 from v35 to v36

#### Added

added HP Desktop Mini DVD Super Multi-Writer ODD Expansion Module to Data Storage Drives and Accessories

added HP Desktop Mini I/O Expansion Module to Input Devices

added HP Desktop Mini DVD Super Multi-Writer ODD Expansion Module under Multimedia Devices

added HP Desktop Mini Security/Dual VESA Sleeve under Security Devices



#### After-Market Options (availability may vary by region)

added under Stands and Accessories, HP Desktop Mini Rack Mount Module

#### April 28, 2015 from v36 to v38

#### Added

Added to the processors

Intel® Core™ i3-4170 Processor

Intel® Pentium G3470 Processor

Intel® Pentium G3260 Processor

Added under Solid State Drives (SSD) & Self-encrypting Solid State Drives (SED)

128GB SATA 2.5 SSD TLC Non-SED (with 3.5" adapter when needed)

256GB SATA 2.5 SSD TLC Non-SED (with 3.5" adapter when needed)

512 GB SATA 2.5 SSD (Non-SED)

Added chart

HP 256 GB\* (non-SED) TLC Solid State Drive, HP 128 GB\* (non-SED) TLC Solid State Drive and HP 512 GB\* (non-SED) TLC Solid State Drive

#### Remove

Removed from certified under OS

**REd Hat Enterprise Linux 64** 

RHEL 6 - Red HAt Enterprise Linux 6 (32/64-bit) - Only for HP ProDesk 600 G1 DM

the following features are not supported by Red Hat Enterprise Linux 64, and the features

#### May 20, 2015 From v38 to v39

Addition

Added and "X" mark under DM for Solenoid Hood Lock / Sensor

#### July 6, 2015 From v39 to v40

#### **Addition**

Added a new note under Storage

#### Changed

Changed OS

#### August 25, 2015 From v40 to v41

Change

Change from "HP Slim SuperMulti DVD Writer Drive" the value from "DVD-RW" from 6 to 8

#### October 7, 2015 From v41 to v42

Added note about AMD and NVIDIA graphics cards are not available for Windows 10

